Overview

HP Z6 G4 Workstation



Front view

- 1. Integrated Front Handle
- 2. Front I/O module options
 - Premium (optional, shown here): power button, 2 USB 3.1 G1 Type-A, 2 USB 3.1 G2 Type-C[™] (Left-most Type A port has charging capability), Headset/Mic, Media Card Reader (optional).
 - Standard: power button, 4 USB 3.1 G1 Type-A (left-most Type A port has charging capability), Headset/Mic, Media Card Reader (optional).
- 3. 2 x 5.25" external bays
- 4. 1 Slim ODD bay



Overview



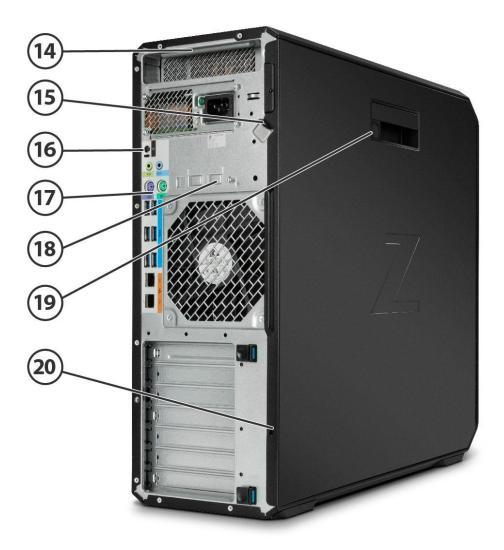
Internal view

- 5. Power supply: 1000W 90% efficient with 2 graphics power adapters
- 6. 6 DIMM slots: DDR4-2666 Registered RAM
- 7. Intel® Xeon® processor Scalable family
- 8. 2nd CPU & memory riser connector: adds 2nd CPU socket and (6) DIMM slots
- 9. PCIe slots: 2 PCIe G3 x16, 3 PCIe G3 x4, 1 PCIe G3 x8

- 10. 6 x 6Gb/s SATA ports
- 11. 2 PCle G3 x4 M.2 for SSDs
- 12. 2 x 2.5"/3.5" internal drive bays
- 13. 2 x 5.25" external drive bays



Overview



14. Rear handle

- 15. Padlock loop
- 16. Rear power button
- 17. Rear I/O (top to bottom):audio in/out, keyboard/mouse PS/2,6 USB 3.1 G1 Type-A,2 x 1GbE LAN ports

Rear view

- 18. HP Dual Port 10GBase-T NIC module slot (optional)
- 19. Side panel barrel keylock (optional)
- 20. Kensington lock slot



Overview

Overview

Form Factor
Operating Systems

Tower

Preinstalled:

- Windows 10 Pro for Workstations¹
- Ubuntu 20.04 LTS²
- HP Linux-ready (minimal OS ready for customer OS installation)
- Red Hat® Enterprise Linux® Desktop Workstation (Paper license with 1 year support; no preinstalled OS)

Supported:

- Red Hat Enterprise Linux Workstation 6, 7, 8³
- SUSE Linux Enterprise Desktop 12, 15³
- Ubuntu 16.04, 18.04, 20.04 LTS²

¹Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply, and additional requirements may apply over time for updates. See http://www.windows.com.

² Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply, and additional requirements may apply over time for updates.

³Notes: For detailed Linux® OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

Note: In accordance with Microsoft's support policy, HP does not support the Windows® 7 operating system on products configured with Intel® 7th Generation and forward processors.

Available Processors

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MT/s)	Hyper- Threading	Intel® Turbo Boost Technology ¹	Supports Intel® DCPMM Technology²	TDP (W)	
			Intel® Xeor	n® W Processo	ors				
Intel® Xeon® W-3275 processor	28	2.5 GHz	38.5	2933	Yes	4.4, 4.6	NO	205	
Intel® Xeon® W-3265 processor	24	2.7 GHz	33	2933	Yes	4.4, 4.6	NO	205	
Intel® Xeon® W-3245 processor	16	3.2 GHz	22	2933	YES	4.4, 4.6	NO	205	
Intel® Xeon® W-3235 processor	12	3.3 GHz	19.25	2933	YES	4.4, 4.5	NO	180	
Intel® Xeon® W-3225 processor	8	3.7 GHz	16.5	2666	YES	4.3, 4.4	NO	160	
Intel® Xeon® W-3223 processor	8	3.5 GHz	16.5	2666	YES	4, 4.2	NO	160	
	Intel® Xeon® Scalable Processors								
Intel® Xeon® Platinum 8280 processor	28	2.7 GHz	38.50	2933	YES	3.3, 4.0	YES	205	



Overview

	I	1	I	I	l		I	
Intel® Xeon® Platinum 8260 processor	24	2.4 GHz	35.75	2933	YES	3.1, 3.9	YES	165
Intel® Xeon® Gold 6258R processor	28	2.7 GHz	38.50	2933	YES	4.0, 3.4	YES	205
Intel® Xeon® Gold 6254 processor	18	3.1 GHz	24.75	2933	YES	3.9, 4.0	YES	200
Intel® Xeon® Gold 6252	24	2.1 GHz	35.75	2933	YES	2.8, 3.7	YES	150
Intel® Xeon® Gold 6248R processor	24	3.0 GHz	35.75	2933	YES	4.0, 3.9	YES	205
Intel® Xeon® Gold 6248 processor	20	2.5 GHz	27.50	2933	YES	3.2, 3.9	YES	150
Intel® Xeon® Gold 6246R processor	16	3.4 GHz	35.75	2933	YES	4.1, 4.0	YES	205
Intel® Xeon® Gold 6244 processor	8	3.6 GHz	24.75	2933	YES	4.3, 4.4	YES	150
Intel® Xeon® Gold 6242R processor	20	3.1 GHz	35.75	2933	YES	4.1, 3.8	YES	205
Intel® Xeon® Gold 6242	16	2.6 GHz	22	2933	YES	3.5, 3.9	YES	150
Intel® Xeon® Gold 6240R processor	24	2.4 GHz	35.75	2933	YES	4.0, 3.2	YES	165
Intel® Xeon® Gold 6240Y processor	18	2.6 GHz	24.75	2933	YES	3.3, 3.9	YES	150
Intel® Xeon® Gold 6240 processor	18	2.6 GHz	24.75	2933	YES	3.3, 3.9	YES	150
Intel® Xeon® Gold 6238R processor	28	2.2 GHz	38.5	2933	YES	4.0, 3.0	YES	165
Intel® Xeon® Gold 6238	22	2.1 GHz	30.25	2933	YES	3.4, 3.7	YES	140
Intel® Xeon® Gold 6234 processor	8	3.3 GHz	24.75	2933	YES	4.0, 4.0	YES	130
Intel® Xeon® Gold 6230R processor	26	2.1 GHz	35.75	2933	YES	4.0, 3.0	YES	150
Intel® Xeon® Gold 6230 processor	20	2.1 GHz	27.50	2933	YES	2.8, 3.9	YES	125
Intel® Xeon® Gold 6226R processor	16	2.9 GHz	22	2933	YES	3.9, 3.6	YES	150
Intel® Xeon® Gold 6226 processor	12	2.7 GHz	19.25	2933	YES	3.5, 3.7	YES	125
Intel® Xeon® Gold 6154 processor	18	3.0 GHz	24.75	2666	YES	3.7, 3.7	NO	200
Intel® Xeon® Gold 6136 processor	12	3.0 GHz	24.75	2666	YES	3.6, 3.7	NO	150
Intel® Xeon® Gold 6132 processor	14	2.6 GHz	19.25	2666	YES	3.3, 3.7	NO	140
Intel® Xeon® Gold 6128 processor	6	3.4 GHz	19.25	2666	YES	3.7, 3.7	NO	115
Intel® Xeon® Gold 5222 processor	4	3.8 GHz	16.5	2666	YES	3.9, 3.9	YES	105
Intel® Xeon® Gold 5220R processor	24	2.2 GHz	35.75	2666	YES	4.0, 2.9	YES	150
Intel® Xeon® Gold 5220 processor	18	2.2 GHz	24.75	2666	YES	2.7, 3.9	YES	105



Overview

Intel® Xeon® Gold 5218R processor	20	2.1GHz	27.5	2666	YES	4.0, 2.9	YES	125
Intel® Xeon® Gold 5218 processor	16	2.3 GHz	22	2666	YES	2.8, 3.9	YES	125
Intel® Xeon® Gold 5215 processor	10	2.5 GHz	13.75	2666	YES	3.0, 3.4	YES	85
Intel® Xeon® Gold 5118 processor	12	2.3 GHz	16.50	2400	YES	2.7, 3.2	NO	105
Intel® Xeon® Silver 4216 processor	16	2.1 GHz	22	2400	YES	2.7, 3.2	NO	100
Intel® Xeon® Silver 4215R processor	8	3.2 GHz	11	2400	YES	4.0, 3.6	YES	130
Intel® Xeon® Silver 4215 processor	8	2.5 GHz	11	2400	YES	3.0, 3.5	YES	85
Intel® Xeon® Silver 4214R processor	12	2.4 GHz	16.5	2400	YES	3.0, 3.5	NO	100
Intel® Xeon® Silver 4214Y processor	12	2.2 GHz	16.5	2400	YES	2.7, 3.2	NO	85
Intel® Xeon® Silver 4214 processor	12	2.2 GHz	16.5	2400	YES	2.7, 3.2	NO	85
Intel® Xeon® Silver 4210R processor	10	2.4 GHz	13.75	2400	YES	2.9, 3.2	NO	100
Intel® Xeon® Silver 4210 processor	10	2.2 GHz	13.75	2400	YES	2.7, 3.2	NO	85
Intel® Xeon® Silver 4208 processor	8	2.1 GHz	11	2400	YES	2.5, 3.2	NO	85
Intel® Xeon® Silver 4114 processor	10	2.2 GHz	13.75	2400	YES	2.5, 3.0	NO	85
Intel® Xeon® Silver 4112 processor	4	2.6 GHz	8.25	2400	YES	2.9, 3.0	NO	85
Intel® Xeon® Silver 4108 processor	8	1.8 GHz	11.00	2400	YES	2.1, 3.0	NO	85
Intel® Xeon® Bronze 3206R processor	8	1.9 GHz	11.00	2133	YES	N/A	NO	85
Intel® Xeon® Bronze 3204 processor	6	1.9 GHz	8.25	2133	YES	N/A	NO	85
Intel® Xeon® Bronze 3106 processor	8	1.7 GHz	11.00	2133	NO	N/A	NO	85
		-	-	-	-		-	-

All Z6G4 Intel® Xeon® CPUs Feature Intel® vPro™ Technology.

¹The specifications shown in this column represent the following: (all core maximum turbo frequency, one core maximum turbo frequency). Processors that do not have turbo functionality are denoted as N/A.

²Intel® Data Center Persistent Memory Modules availability will be announced at a future date.

Available Processors Disclaimers

When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families.

Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock



Overview

frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher

performance.

Black Color

Convertibility No

Expansion Slots (see more details)

Slot 0:

system board section for Mechanical-only, for use with devices that require only rear bulkhead mounting or when 2nd CPU riser is installed

Slot 1:

PCI Express Gen3 x4 - CPU with open-ended connector*

Slot 2:

PCI Express Gen3 x16 - CPU

Slot 3:

PCI Express Gen3 x4 - PCH with open-ended connector*

Slot 4:

PCI Express Gen3 x8 - CPU with open-ended connector (slot converts to x4 electrical when SSD is installed in 2nd M.2 slot)*

Slot 5:

PCI Express Gen3 x16 - CPU

Slot 6:

PCI Express Gen3 x4 - PCH with open-ended connector*

M.2 PCle Gen 3 x4 - CPU up to 80mm storage devices

M.2 Slot 2:

M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

* Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.

Expansion Bays (see storage section for more 2 external 5.25" bays details)

2 internal 3.5" bays (with acoustic dampening rail assemblies pre-installed)

- 3rd and 4th 3.5" HDD each occupy one external bay
- 3rd and 4th 2.5" HDD/SSD occupy a single external bay within a 2:1 carrier)

1 dedicated 9.5mm slim optical disk drive bay

Front I/O

- Base: Power button, 1 Headset audio port, 4 USB 3.1 G1 Type A (1 charging)
- Premium (optional): Power button, 1 Headset audio port, 2 USB 3.1 G2 Type C™, 2 USB 3.1 G1 Type A (1 charging)
- Optional: SD reader



Overview

Internal I/O 1 USB 3.1 G1 (aka USB 3.0) single-port header, 1 USB 2.0 single-port header and 1 USB 2.0 dual-port

header

Rear I/O 6 USB 3.1 G1 (aka USB 3.0) Type A ports, 2 1Gbe LAN ports (1x supporting Intel® AMT), Audio: 1 Line

out, 1 Line in (Line in can be retasked as microphone), 1 PS/2 mouse port, 1 PS/2 keyboard port, 1 Rear

power button

Optional: 1 serial port (cable up to rear bulkhead)

Interfaces Supported SD card reader (optional)

6-channel SATA interface (6 @ 6.0 Gb/s)

6 channels are eSATA configurable for use with eSATA CTO/AMO Kit (No hot plug / hot swap

supported)

USB 2.0, USB 3.1 G1 (aka USB 3.0), USB 3.1 G2 (optional)

On-board RAID Support SATA RAID 0 Striped Array

SATA RAID 1 Mirrored Array SATA RAID 5 Striped/Parity SATA RAID 10 Striped/Mirrored

Chassis Dimensions (H x

WxD)

H: 17.5" (445mm) W: 6.65" (169mm) D: 18.3" (465mm)

Packaged Dimensions H: 24" (610mm)

W: 12.3" (313mm) D: 23.3" (593mm)

Palletization Profile

6 units x 3 layers = 18 units per pallet 1200x1000x1836mm (pallet included)

Rack Dimensions 4U

Weight Exact weights depend upon configuration (System weight only).

Minimum: 13.1 kg (29 lbs.) Standard: 13.6 kg (30.1 lbs.) Maximum: 23.9 kg (52.7 lbs.)

Temperature Operating: 5° to 35°C (40° to 95°F)

Non-operating: -40° to 60°C (-40° to 140°F)

Note: Above 1524 m (5,000 feet) altitude, maximum operating temperature is reduced by 1° C (1.8° F)

per 305 m (1,000 feet) elevation increase

Humidity Operating: 10% to 85% relative humidity, non-condensing, 35° C maximum wet bulb

Non-operating: 10% to 90% relative humidity, non-condensing, 35° C maximum wet bulb

Maximum Altitude (non-

pressurized)

Operating: 3,048m (10,000ft) Non-operating: 9,144m (30,000ft)

Note: Above 1524 m (5,000 feet) altitude, maximum operating temperature is reduced by 1° C (1.8° F)

per 305 m (1,000 feet) elevation increase

Power Supply 1000 watts wide-ranging, active Power Factor Correction, 90% Efficient, with 2X 6-pin graphics power

cables (graphics power cables are 6/8-pin convertible)

The Z6 G4 1000W power supply efficiency report can be found at this link:

 $https://plugloadsolutions.com/psu_reports/HP_D15-1K0P1A_1000W_ECOS\%204838_Report.pdf$



Overview

Workstation ISV Certifications

See the latest list of certifications at

http://www8.hp.com/us/en/campaigns/workstations/industries-and-partners.html



Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Number ¹	Support Notes
	Intel® Xeon® W-3200 Series CPU	Comigured	KIL	Number	Notes
	Intel® Xeon® W-3275 2.5 2933 28C processor	Υ	N		
	Intel® Xeon® W-3265 2.7 2933 24C processor	Υ	N		
	Intel® Xeon® W-3245 3.2 2933 16C processor	Υ	N		
	Intel® Xeon® W-3235 3.3 2933 12C processor	Υ	N		
	Intel® Xeon® W-3225 3.7 2666 8C processor	Υ	N		
	Intel® Xeon® W-3223 3.5 2666 8C processor	Υ	N		
	Intel® Xeon® Scalable CPU				
	Intel® Xeon® Platinum 8280 processor	Υ	N		1
	Intel® Xeon® Platinum 8260 processor	Υ	N		1
	Intel® Xeon® Gold 6258R processor	Υ	N		
	Intel® Xeon® Gold 6254 processor	Υ	N		1
	Intel® Xeon® Gold 6252 processor	Υ	Υ	5YT07AA	1
	Intel® Xeon® Gold 6248R processor	Υ	N		
	Intel® Xeon® Gold 6248 processor	Υ	Υ	5YT06AA	1
	Intel® Xeon® Gold 6246R processor	Υ	N		
	Intel® Xeon® Gold 6244 processor	Υ	Υ	5YT05AA	1
	Intel® Xeon® Gold 6242R processor	Υ	N		1
	Intel® Xeon® Gold 6242 processor	Υ	Υ	5YT04AA	1
	Intel® Xeon® Gold 6240R processor	Υ	N		1
	Intel® Xeon® Gold 6240Y processor	Υ		5YT03AA	1
	Intel® Xeon® Gold 6240 processor	Υ	Υ	5YT02AA	1
	Intel® Xeon® Gold 6238R processor	Υ	N		1
	Intel® Xeon® Gold 6238 processor	Υ	Υ	5YT01AA	1
	Intel® Xeon® Gold 6234 processor	Υ	Υ	5YT00AA	1
	Intel® Xeon® Gold 6230R processor	Υ	Υ	9VA87AA	1
	Intel® Xeon® Gold 6230 processor	Υ	Υ	5YS99AA	1
	Intel® Xeon® Gold 6226R processor	Υ	Υ	9VA85AA	1
	Intel® Xeon® Gold 6226 processor	Υ	Υ	5YS98AA	1
	Intel® Xeon® Gold 6154 processor	Υ	N		
	Intel® Xeon® Gold 6136 processor	Υ	Υ	1XM39AA	
	Intel® Xeon® Gold 6134 processor	Υ	Υ	1XM41AA	
	Intel® Xeon® Gold 6132 processor	Υ	Υ	1XM42AA	
	Intel® Xeon® Gold 6128 processor	Υ	Υ	1XM44AA	
	Intel® Xeon® Gold 5222 processor	Υ	Υ	5YS97AA	1
	Intel® Xeon® Gold 5220R processor	Υ	Υ	8BC99AA/AT	1
	Intel® Xeon® Gold 5220 processor	Υ	Υ	5YS96AA	1
	Intel® Xeon® Gold 5218R processor	Υ	Υ	9VA83AA	1
	Intel® Xeon® Gold 5218 processor	Υ	Υ	5YS95AA	1
	Intal® Voon® Cold F31E processor	V	V	EVCOAAA	1



Intel® Xeon® Gold 5215 processor

1

Υ

5YS94AA

Supported Components

Intel® Xeon® Gold 5118 processor	Υ	Υ	1XM45AA	
Intel® Xeon® Gold 4216 processor	Υ	Υ	5YS93AA	
Intel® Xeon® Gold 4215R processor	Υ	Υ	9VA81AA	
Intel® Xeon® Gold 4215 processor	Υ	Υ	5YS92AA	1
Intel® Xeon® Gold 4214R processor	Υ	Υ	8BC96AA/AT	1
Intel® Xeon® Gold 4214Y processor	Υ	Υ	5ZB33AA	
Intel® Xeon® Gold 4214 processor	Υ	Υ	5YS91AA	
Intel® Xeon® Gold 4210R processor	Υ	Υ	8BC95AA	
Intel® Xeon® Gold 4210 processor	Υ	Υ	5YS90AA	
Intel® Xeon® Gold 4208 processor	Υ	Υ	5YS89AA	
Intel® Xeon® Silver 4114 processor	Υ	Υ	1XM49AA	
Intel® Xeon® Silver 4112 processor	Υ	Υ	1XM50AA	
Intel® Xeon® Silver 4108 processor	Υ	Υ	1XM51AA	
Intel® Xeon® Bronze 3206R processor	Υ	Υ	8BC93AA	
Intel® Xeon® Bronze 3204 processor	Υ	Υ	5YS88AA	
Intel® Xeon® Bronze 3106 processor	Υ	Υ	1XM52AA	

¹ Options kits available for second processor upgrade.

Disclaimers: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families.

Note 1: Intel® DCPMM® (Data Center Persistent Memory) Supported.

Monitors / Displays		Factory Configured	Option Kit	Option Kit Support Part Number Notes
	HP Z Display Z22n G2		Υ	1JS05AA
	HP Z Display Z23n G2		Υ	1JS06AA
	HP Z Display Z24i G2		Υ	1JS08AA
	HP Z Display Z24n G2		Υ	1JS09AA
	HP Z Display Z24nf G2		Υ	1JS07AA
	HP Z Display Z27n G2		Υ	1JS10AA
	HP Z Display Z27s (4K display)		Υ	J3G07AA
	Supported by all operating systems available from HP Screen size measured diagonally			

Storage / Hard Drives

SAS Hard Drives				Option	
		Factory	Option	Kit Part	Support
	SAS Hard Drives for HP Workstations	Configured	Kit	Number	Notes



Supported Components

HP 300GB 15k SAS SFF

Y Y L5B74AA

NOTE: SAS controller add-in card required

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SATA (Serial ATA) Hard Drives for HP Workstations				
	500GB SATA 7200RPM 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA	
	500GB SATA 7200RPM 6Gb/s OPAL2 SFF 3.5" HDD	Υ	Υ	D8N29AA	
	1TB SATA 7200RPM 3.5" HDD	Υ	Υ	LQ037AA	
	1TB SATA 7200RPM Ent 3.5" HDD	Υ	Υ	W0R10AA	
	2TB SATA 7200RPM HDD	Υ	Υ	QB576AA	
	2TB 7200RPM SATA 3.5in Enterprise	Υ	Υ	2Z274AA	
	4TB SATA 7200RPM Ent 3.5" HDD	Υ	Υ	K4T76AA	
	6TB SATA 7200RPM Ent 3.5" HDD	Υ	Υ	3DH90AA	
	8TB 7200RPM SATA 3.5in Enterprise	Υ	Υ	2Z273AA	
	NOTES:				

Up to (4) 3.5-inch 7200 rpm SATA drives: 500 GB, 1.0, 2.0, 4.0 TB; maximum system HDD storage: 16.0TB



Supported Components

SATA Solid State Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Solid State Drives (SSDs) for Workstations				
	HP 256GB SATA SSD	Υ	Υ	A3D26AA	
	HP 512GB SATA SSD	Υ	Υ	D8F30AA	
	HP 1TB SATA SSD	Υ	Υ	F3C96AA	
	HP 2TB SATA SSD	Υ	Υ	Y6P08AA/AT	
	HP 256GB SATA SED OPAL2 SSD	Υ	Υ	G7U67AA	
	HP 512GB SATA SED OPAL2 SSD	Υ	Υ	N8T26AA	
	HP 240GB SATA Enterprise SSD	Υ	Υ	T3U07AA	
	HP 480GB SATA Enterprise SSD	Υ	Υ	T3U08AA	
	HP 960GB 2.5in Enterprise SATA-3 SSD	Υ	Υ	1W6P8AA	
	1920GB 2 5in Enterprise SATA-3 SSD	Υ	١	1W6P9A	AΑ

PCIe Solid State Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	PCIe SSDs for HP Workstations				
	HP Z Turbo Drive 256GB MLC Z4/Z6 G4 SSD Kit	Υ	Υ	1PD56AA	4
	HP Z Turbo Drive 512GB MLC Z4/Z6 G4 SSD Kit	Υ	Υ	1PD57AA/AT	4
	HP Z Turbo Drive 1TB MLC Z4/Z6 G4 SSD Kit	Υ	Υ	1PD58AA	4
	HP Z Turbo Drive 256GB TLC Z4/Z6 G4 SSD Kit	Υ	Υ	1PD59AA/AT	
	HP Z Turbo Drive 512GB TLC Z4/Z6 G4 SSD Kit	Υ	Υ	1PD60AA	
	HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SSD Kit	Υ	Υ	1PD61AA	
	HP Z Turbo Drive 2TB TLC Z4/Z6 G4 SSD Kit	Υ	Υ	3KP39AA	
	HP Z Turbo Drive 256GB Z4/Z6 G4 SED Kit	N	N	EOL	4
	HP Z Turbo Drive 512GB Z4/Z6 G4 SED Kit	N	N	EOL	4
	HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SED Kit	Υ	Υ	6YT76AA	
	HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SED Module	Υ	Υ	6YT79AA	
	HP Z Turbo 2TB SED OPAL2 TLC M.2 Z4/Z6 SSD	Υ	Υ	2Y7W6AA	
	HP 256GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit	Υ	Υ	8PE68AA	3
	HP 512GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit	Υ	Υ	8PE69AA	3
	HP 1TB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit	Υ	Υ	8PE70AA	3
	HP 256GB M.2 2280 PCIe NVMe TLC SSD Module	N	Υ	8PE62AA	2
	HP 512GB M.2 2280 PCIe NVMe TLC SSD Module	N	Υ	8PE63AA	2
	HP 1TB M.2 2280 PCIe NVMe TLC SSD Z2 Module	N	Υ	8PE64AA	2
	HP 2TB PCIe NVME TLC M.2 Z4/6 G4 SSD	Υ	Υ	35F74AA	
	HP Z Turbo Drive Dual Pro				
	HP Z Turbo Drive Dual Pro 256GB TLC SSD	Υ	Υ	4YF60AA	3
	HP Z Turbo Drive Dual Pro 512GB TLC SSD	Υ	Υ	4YF61AA	3



Supported Components

HP Z Turbo Drive Dual Pro 1TB TLC SSD	Υ	Υ	4YF62AA	3
HP Z Turbo Drive Dual Pro 2TB TLC SSD	Υ	Υ	4YF63AA	3
HP 256GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit	Υ	Υ	8PE74AA	3
HP 512GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit	Υ	Υ	8PE75AA	3
HP 1TB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit	Υ	Υ	8PE76AA	3
HP Z Turbo Drive Quad Pro				
HP Z Turbo Drive Quad Pro 2x256GB PCle TLC SSD	Υ	Υ	4YZ38AA	1
HP Z Turbo Drive Quad Pro 2x512GB PCIe TLC SSD	Υ	Υ	4YZ39AA	1
HP Z Turbo Drive Quad Pro 2x1TB PCIe TLC SSD	Υ	Υ	4YZ40AA	1
HP Z Turbo Drive Quad Pro 2x2TB PCIe TLC SSD	Υ	Υ	3KP42AA	
HP Z Turbo Drive Quad Pro 256GB SSD module	N	Υ	N2N00AA	2
HP Z Turbo Drive Quad Pro 512GB SSD module	N	Υ	N2N01AA	2
HP Z Turbo Drive Quad Pro 1TB SSD module	N	Υ	T9J00AA	2
HP Z Turbo Drive Quad Pro 2TB SSD module	N	Υ	3KP43AA	
Intel® 905p Series SSD (Opatane SSD)				
Intel® Optane SSD 905p 280GB AiC**	Υ	Υ	2SC47AA	
Intel® Optane SSD 905p 480GB AiC**	Υ	Υ	2SC48AA	
Intel® Optane SSD 905p 380GB M.2 SSD Module	Υ	Υ	6LA66AA	

Note 1: Dual M.2 SSD modules plus carrier and heat sink

Note 2: M.2 SSD module only, for Quad Pro or Dual Pro carrier

Note 3: Single M.2 SSD module plus dual carrier and heat sink

Note 4: These M.2 SSD kits and module are End of Life and no longer available.

^{**} PCIe card installed in standard PCIe x4 slot

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SAS Controller				
	MicroSemi SmartHBA2100-4i4e SAS Controller	Υ	Υ	1FV90AA	

Graphics

Factory Option Option Kit Support ^{Supp} Configured Kit Part Number Notes # of	cards
Graphics Cable Adapters	
HP DisplayPort to VGA Adapter Y Y AS615AA	
HP DisplayPort to HDMI Adapter Y Y K2K92AA	
HP DisplayPort to Dual Link DVI Adapter Y Y NR078AA	1
HP DisplayPort to DVI-D Adapter Y Y FH973AA	1
HP DisplayPort to DVI-D Adapter (2-pack) Y N	1
HP DisplayPort to DVI-D Adapter (4-pack) Y N	1



Supported Components

HP DisplayPort to DVI-D Adapter (6-pack)	Υ	N		1
NVIDIA® SLI 3-slot Graphics Connector	Υ	Υ	2YY85AA	1
NVIDIA NVLink 3 Slot Bridge	Υ	Υ	340L3AA	2
Entry 3D				
NVIDIA® Quadro® P400 2GB Graphics	Υ	Υ	1ME43AA	2
NVIDIA® Quadro® P620 2GB Graphics	Υ	Υ	3ME25AA	2
NVIDIA® T400 2 GB GDDR6 LP Blower Fan 3mDP PCle x16 Graphics	Υ	Υ	340K8AA	2
NVIDIA® T600 4 GB GDDR6 LP Blower Fan 4mDP PCle x16 Graphics	Υ	Υ	340K9AA	2
AMD FirePro™ W2100 2GB Graphics	Υ	Υ	J3G91AA	2
Mid-range 3D				
NVIDIA® Quadro® P1000 4GB Graphics	Υ	Υ	1ME01AA	3
NVIDIA® Quadro® P2000 5GB Graphics	Υ	Υ	1ME41AA	2
NVIDIA® Quadro® P2200 5GB Graphics	Υ	Υ	6YT67AA	2
AMD Radeon™ Pro WX 3100 4GB Graphics	Υ	Υ	2TF08AA	2
AMD Radeon™ Pro WX 3200 4GB Graphics	Υ	Υ	6YT68AA	2
AMD Radeon™ Pro WX 4100 4GB Graphics	Υ	Υ	ZOB15AA	2
NVIDIA® T1000 4 GB 4mDP Graphics	Υ	Υ	20X22AA/AT	2
High End 3D				
NVIDIA® Quadro® P4000 8GB Graphics	Υ	Υ	1ME40AA	2
NVIDIA® Quadro RTX 4000 8GB Graphics	Υ	Υ	5JV89AA	2
NVIDIA® RTX A4000 16 GB 4DP Graphics	Υ	Υ	20X24AA/AT	2
AMD Radeon™ Pro W5500 8GB 4DP GFX	Υ	Υ	9GC16AA/AT	2
AMD Radeon™ Pro W5700 8GB 5mDP+USBc GFX	Υ	Υ	9GC15AA/AT	1
AMD Radeon™ Pro WX 7100 8GB Graphics	Υ	Υ	ZOB14AA	2
Ultra High-End 3D				
NVIDIA® Quadro® GP100 16GB Graphics	Υ		1ZE81AA	1
NVIDIA® Quadro® P5000 16GB Graphics	Υ	Υ	Z0B13AA	2
NVIDIA® Quadro® P6000 24GB Graphics	Υ	Υ	Z0B12AA	1
NVIDIA® Quadro RTX 5000 16GB Graphics	Υ	Υ	5JH81AA	1
NVIDIA® Quadro RTX 6000 24GB Graphics	Υ	Υ	5JH80AA	1
NVIDIA® Quadro RTX 8000 48GB Graphics	Υ	Υ	6NB51AA	1
NVIDIA® RTX A5000 24 GB Graphics	Υ	Υ	20X23AA	2
NVIDIA® RTX A6000 48 GB 4DP Graphics	Υ	Υ	2S6U3AA	1
AMD Radeon™ Pro WX 9100 16GB Graphics	Υ	Υ	2TF01AA	1
NVIDIA® Quadro® Sync II	Υ	Υ	1WT20AA	

Memory	SL Processor	CL Processor	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
DDR4-2666 ECC Registered DIMMs						
8GB (1x8GB) DDR4-2666 ECC Reg Memory	Υ	N	Υ	Υ	1XD84AA	1,2



Supported Components

16GB (1x16GB) DDR4-2666 ECC Reg Memory	Υ	N	N	Υ	1XD85AA	1,2
32GB (1x32GB) DDR4-2666 ECC Reg Memory	Υ	N	N	Υ	1XD86AA	1,2
DDR4-2933 ECC Registered DIMMs						
8GB (1x8GB) DDR4-2933 ECC Reg Memory	Υ	Υ	Υ	Υ	5YZ56AA	1,2
16GB (1x16GB) DDR4-2933 ECC Reg Memory	N	Υ	N	Υ	5YZ54AA	1,2
32GB (1x32GB) DDR4-2933 ECC Reg Memory	N	Υ	N	Υ	5YZ55AA	1,2
64GB (1x64GB) DDR4-2399 ECC Reg Memory	N	Υ	N	Υ	5YZ57AA	1,2

SL Processor: Are processors formerly known as Intel® Skylake that are sold under the model name Intel® Xeon® SP: Platinum 8100, Gold 6100, Gold 5100, Silver 4100 and Bronze 3100 Family

CL Processor: Are processors formerly known as Intel® Cascade Lake that are sold under the model name Intel® Xeon® SP: Platinum 8200, Gold 6200, Gold 5200, Silver 4200 and Bronze 3200 Family

NOTES:

1: For details on the supported memory configurations on the HP Z6 G4 Workstation, please refer to the System Technical Specifications - System Board section of this document.

Each processor supports up to 6 channels of DDR4 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

With single-processor configurations, 6 DIMM slots are available. 6 additional DIMM slots are available with the 2nd CPU & Memory Module.

The CPUs determine the speed at which the memory is clocked. If a 2400MT/s capable CPU is used in the system, the maximum speed the memory will run at is 2400MT/s, regardless of the specified speed of the memory.

The Z6 G4 is designed to work ONLY with DDR4 memory. The system will not work with DDR3 memory.

2: Z6 G4 configurations that include a 2nd CPU require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA). Z6 G4 configurations that include greater than 32GB total system memory require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA).

NOTE: Factory-configured CTO (xxxxxAV) and aftermarket AMO (xxxxxAA, xxxxxAT) HP memory part numbers designated as "2666" may ship with "2933" or "3200" speed memory components. Similarly, HP Memory part numbers designated as "2933" may ship with "3200" speed memory. This does not affect HP part number availability, nor does it affect system performance or operation. All hardware configurations currently supporting HP memory part numbers designated as "2666" or 2933 have been fully qualified to work with fast speed memory and are fully supported by HP under standard support terms.

NVDIMM Memory		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Intel® Optane™ DC Persistent Memory (DCPMM)				
	128GB (1x128GB) DC Persistent Memory Module	Υ	Υ	9NH78AA	1
	256GB (2x128GB) DC Persistent Memory Configuration	Υ	N		1
	512GB (4x128GB) DC Persistent Memory Configuration	Υ	N		1,2

NOTE 1: Supported only with Xeon 82xx, 62xx, 52xx and 4215/4215R processors.

- a. Available as factory configured in Memory Mode or Storage Mode.
- b. Systems configured with DCPMM memory will operate the memory subsystem at 2666 MT/s.



Supported Components

- c. Operating System Support:
 - i. Windows 10 Pro for Workstations v1903 or later with all updates applied.
 - ii. Linux OS support may be found in the Linux Hardware Support Matrix.
- d. Detailed setup, security and support information may be found in the Intel® Optane™ DC Persistent Memory: Configuration and Setup on HP Z6 G4 and Z8 G4 Workstation white paper.
- e. DCPMM solutions require additional DRAM memory to be included in the solution:
 - i. Systems configured with DCPMM in Memory Mode will include DRAM memory to be used as cache. The amount of included DRAM memory is based on an 8:1 DCPMM to DRAM capacity ratio.
 - ii. Systems configured with DCPMM in Storage Mode will require DRAM System Memory to be ordered separately.
 - iii. DCPMM Memory will report approximately 2% less than advertised capacity .
- f. Total Memory (DCPMM + DRAM) per processor must be <= 1TB or 2TB per dual processor system.
 - i. When configured in memory mode, additional DRAM does not count against maximum processor memory.
- g. Maximum number of DCPMM modules in a Z6G4 is 4 per processor.
- h. Customer is responsible for additional required DRAM when adding DCPMM modules in Memory Mode.
- i. HP Z6G4 configured with some AMD Graphics are limited to 1TB of total DCPMM and DRAM memory. See AMD Graphics specifications for details.

NOTE 2: Requires 2nd processor option.

Multimedia and Audio Devices



Supported Components

Multimedia and Audio Devices

Option Kit
Factory Part Support
Configured Option Kit Number Notes

Ν

Integrated Realtek HD ALC221 Audio

Optical and Removable Storage

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP SlimTray Optical Drives				
HP 9.5mm Slim Blu Ray Disc Writer	Υ	Υ	K3R65AA	
HP 9.5mm Slim DVD ROM	Υ	Υ	K3R63AA	
HP 9.5mm Slim DVD Writer	Υ	Υ	K3R64AA	
HP Half Height Optical Drives				
HP HH DVD Writer (16X RW DVD-R)	N	Υ	4AR67AA	
HP SD Card Reader				
HP SD 4 Card Reader	Υ	Υ	Y0L99AA	
HDD Frame/Carriers				
HP DX175 Removable HDD Carrier	N	Υ	1ZX72AA	
HP DX175 Removable HDD Frame/Carrier	N	Υ	1ZX71AA	
NVMe Frame/Carrier				
HP QX310 Removable NVMe Frame/Carrier w/PCIe card	Υ	N	8GQ89AA/AT	
HP QX310 Removable Carrier only	N	Υ	8GQ91AA/AT	

Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Networking and Communications

	Option Kit				
	Factory		Part		
	Configured	Option Kit	Number	Support Notes	
HP i350-T2 PCIe Dual Port Gigabit NIC	Υ	Υ	V4A91AA		
Intel® i350-T4 PCIe 4-Port Gigabit NIC	N	Υ	W8X25AA		
Intel® Ethernet I210-T1 PCIe x1 Gb NIC	Υ	Υ	E0X95AA		
Aquantia® NBASE-T 5GbE PCle NIC	N	Υ	1PM63AA		



Supported Components

HP Dual Port 10GBase-T NIC Module	Υ	Υ	1QL49AA	
Intel® 8265 802.11 a/b/g/n/ac + BT PCIe WLAN	N	Υ	1QL48AA	
Intel® X550-T2 10GbE Dual Port NIC	Υ	Υ	1QL46AA	
Intel® X710-DA2 10GbE SFP+ Dual Port NIC	Υ	Υ	1QL47AA	1
HP 10GbE SFP+ SR Transceiver	Υ	Υ	C3N53AA	
Intel® Wi-Fi 6 AX200 & BT PCIe	N	Υ	7CE01AA	1
Allied Telesis AT-2914SX/LC-901 1GB LC Fiber NIC Note 1: Windows 7 is NOT supported	Υ	Y	1C7Q2AA	

Racking and Physical Security



Supported Components

Racking and Physical Security

			Option Kit	
	Factory	Ontion Kit	Part Number	Support Notes
	Configured	Option Kit	Number	Notes
HP Z4/Z6 Side Panel Barrel Keylock	Υ	Ν		
HP Solenoid Lock / Hood Sensor	Υ	N		
HP Z4/Z6 Depth Adjustable Fixed Rail Rack Kit	N	Υ	2HW42AA	
HP Z2 Mini/Z2 TWR/Z4/Z6 Dept Adj Fixed Rail Rack Kit		Υ	2A8Y5AA	
HP Keyed Cable Lock 10mm	N	Υ	T1A62AA	

Input Devices

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Wireless Business Slim Keyboard and Mouse	Υ	Υ	N3R88AA	
Business Slim PS/2 Wired Keyboard	Υ	Υ	N3R86AA	
USB Business Slim Wired Keyboard	Υ	Υ	N3R87AA	
USB Premium Wired Keyboard	Υ	Υ	Z9N40AA	
USB Wired SmartCard CCID Keyboard	Υ	Υ	E6D77AA	
HP Optical USB Mouse	Υ	Υ	QY777AA	
HP PS/2 Mouse	Υ	Υ	QY775AA	
HP USB Hardened Mouse	Υ	Υ	P1N77AA	

Other Hardware

	Factory		Option Kit Part	
	Configured	Option Kit	Number	Support Notes
HP ENERGY STAR® Certified Configuration	Υ			
HP Z Premium Front I/O 2xUSB-A 2xUSB-C	Υ	Υ	1XM32AA	
HP Z6 G4 Memory Cooling Solution	Υ	Υ	2HW44AA	Note 1
HP Internal USB Port Kit	N	Υ	EM165AA	Note 2
HP eSATA 2 port PCI Bulkhead Kit	Υ	Υ	GM110AA	
HP Serial Port Adapter	Υ	Υ	PA716A	
HP Workstation Mouse Pad	Υ			

Note 1: Z6 G4 configurations that include a 2nd CPU require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA). Z6 G4 configurations that include greater than 32GB total system memory require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA).

Note 2: The HP Internal USB Port kit has a single USB 2.0 type A connector.



Supported Components

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Sobey Video Editing SW	Υ	N		
	SW HP RGS for Z	Υ	N		
	HP Sure Start Gen3	Υ	N		
	HP Performance Advisor	Υ	N		



Supported Components

Operating Systems

Support Notes

Windows 10 Pro

Windows 7 Professional 64-bit

Ubuntu 20.04 LTS

HP Linux® Installer Kit Note 2

Red Hat® Enterprise Linux® (RHEL) Workstation - Paper License (1yr)

Note 1

NOTE 1: This second OS must be ordered with the HP Linux® Installer Kit as the first OS.

NOTE 2: For detailed Linux® OS/hardware support information, see:

http://www.hp.com/support/linux_hardware_matrix

For detailed Windows 7 OS hardware support information see

http://h10032.www1.hp.com/ctg/Manual/c05857891.pdf.

Intel Xeon® SP Processors: Platinum 8100, Gold 6100, Gold 5100, Silver 4100, & Bronze 3100 Family support Microsoft Windows 7 Professional 64-bit.



System Technical Specifications

System Board

System Board Form Main System Board:

Factor 24 x 31 cm

9.6 x 12.2 inches

2nd CPU/Memory Board (optional):

14.9 x 29.2 cm 5.85 x 11.50 inches

Processor Socket FCLGA3647 (Socket P)

1st CPU on system board

2nd CPU on optional 2nd CPU/Memory Module

CPU Bus Speed UPI: Up to 10.4GT/second, depending on processor

Chipset Intel® C622 Chipset **Super I/O Controller Nuvoton SIO15**

Memory Expansion Slots 6 on system board (CPU0) + 6 on optional 2nd CPU/Memory Module (CPU1)

Memory Type

DDR4 R-DIMM (Registered), ECC: 8GB, 16GB, 32GB, and 64GB

Supported

Memory Modes NUMA (Non-Uniform Memory Architecture), Memory Node Interleave

Memory Speed

2133MT/s, 2400MHz, 2666MT/s, and 2933MT/s

Supported

Available Memory Configurations:

	Single Processor							
			CPU	J 0				
		Top Slots		В	ottom Slo	ts		
Capacity	DIMM1	DIMM2	DIMM3	DIMM4	DIMM5	DIMM6	Perf Rating	
8 GB	8 GB						Fair	
16 GB	8 GB					8 GB	Good	
24 GB	8 GB	8 GB	8 GB				Better	
32 GB	8 GB		8 GB	8 GB		8 GB	Better	
32 GB	16 GB					16 GB	Good	
48 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	Best	
40 GD	16 GB	16 GB	16 GB				Better	
64 GB	16 GB		16 GB	16 GB		16 GB	Better	
04 GB	32 GB					32 GB	Good	
96 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	Best	
90 GB	32 GB	32 GB	32 GB				Better	
128 GB	32 GB		32 GB	32 GB		32 GB	Better	
192 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	Best	
256 GB	64 GB		64 GB	64 GB		64 GB	Better	
384 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	Best	

System Technical Specifications

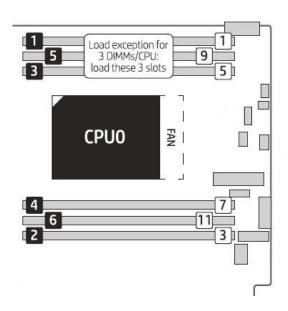
						Dual Pr	ocessor						
		CPU 0 CPU 1											
	1	Γop Slot	S	Во	ttom Sl	ots	-	Γop Slot	S	Во	ttom Slo	ots	
Capacity	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	Rating
16 GB	8 GB						8 GB						Fair
32 GB	8 GB					8 GB	8 GB					8 GB	Good
48 GB	8 GB	8 GB	8 GB				8 GB	8 GB	8 GB				Better
64 GB	8 GB		8 GB	8 GB		8 GB	8 GB		8 GB	8 GB		8 GB	Better
04 GB	16 GB					16 GB	16 GB					16 GB	Good
96 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	8 GB	Best
90 GB	16 GB	16 GB	16 GB				16 GB	16 GB	16 GB				Better
128 GB	16 GB		16 GB	16 GB		16 GB	16 GB		16 GB	16 GB		16 GB	Better
126 GB	32 GB					32 GB	32 GB					32 GB	Good
192 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	16 GB	Best
192 GB	32 GB	32 GB	32 GB				32 GB	32 GB	32 GB				Better
256 GB	32 GB		32 GB	32 GB		32 GB	32 GB		32 GB	32 GB		32 GB	Better
250 GB	64 GB					64 GB	64 GB					64 GB	Best
384 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	32 GB	Better
384 GB	64 GB	64 GB	64 GB				64 GB	64 GB	64 GB				Best
512 GB	64 GB		64 GB	64 GB		64 GB	64 GB		64 GB	64 GB		64 GB	Fair
768 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	64 GB	Good

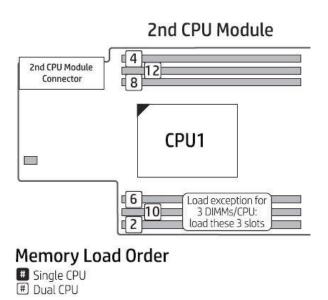


System Technical Specifications

Memory Loading Order:

Load Order for Single and Dual Processor Configuration





Maximum Memory

Supports up to 768 GB DDR4-2933 ECC RAM* (transfer rates up to 2933MT/s) and 384 GB DDR4-2666 ECC RAM (transfer rates up to 2666MT/s).

Memory Configuration (Supported)

- Only Registered ECC DIMMs are supported.
- Do not install memory modules into memory slots if corresponding processor is not installed.
- Dual processor configurations with memory modules installed for only one processor is not supported.

Notes

For systems installed with Microsoft Windows 7 (Ultimate, Enterprise or Pro), the maximum accessible system memory is 192GB

*768 GB configuration requires 2 CPUs configuration.

NVDIMM Memory

Intel® Optane™ DC Persistent Memory is available factory configured in the following capacities:

- 128GB (1x128GB) Single Processor Configuration
- 256GB (2x128GB) Single Processor Configuration
- 512GB (4x128GB) Dual Processor Configuration

NOTES:

- a. Supported only with Xeon 82xx, 62xx, 52xx and 4215/4215R processors.
- b. Available as factory configured in Memory Mode or Storage Mode.
- c. Systems configured with DCPMM memory will operate the memory subsystem at 2666 MT/s.
- d. Operating System Support:
 - i. Windows 10 Pro for Workstations v1903 or later with all updates applied.
 - ii. Linux OS support may be found in the Linux Hardware Support Matrix.
- e. Detailed setup, security and support information may be found in the Intel® Optane™ DC Persistent Memory: Configuration and Setup on HP Z6 G4 and Z8 G4 Workstation_white paper.
- f. DCPMM solutions require additional DRAM memory to be included in the solution:



System Technical Specifications

- i. Systems configured with DCPMM in Memory Mode will include DRAM memory to be used as cache. The amount of included DRAM memory is based on an 8:1 DCPMM to DRAM capacity ratio.
- ii. Systems configured with DCPMM in Storage Mode will require DRAM System Memory to be ordered separately.
- iii. DCPMM Memory will report approximately 2% less than advertised capacity.
- g. Total Memory (DCPMM + DRAM) per processor must be <= 1TB or 2TB per dual processor system.
 - i. When Configured in Memory Mode, additional DRAM does not count against maximum processor memory.
 - ii. Maximum number of DCPMM modules in a Z6G4 is 4 per processor.
- h. Customer is responsible for additional required DRAM when adding DCPMM modules in Memory Mode.
- i. HP Z6G4 configured with some AMD Graphics are limited to 1TB of total DCPMM and DRAM memory. See AMD Graphics specifications for details.

PCI Express Connectors Slot 0:

Mechanical-only, for use with devices that require only rear bulkhead mounting or when 2nd CPU riser is installed

Slot 1:

PCI Express Gen3 x4 - CPU with open-ended connector*

Slot 2:

PCI Express Gen3 x16 - CPU

Slot 3:

PCI Express Gen3 x4 - PCH with open-ended connector*

Slot 4:

PCI Express Gen3 x8 – CPU with open-ended connector (slot converts to x4 electrical when SSD is installed in 2nd M.2 slot)*

Slot 5:

PCI Express Gen3 x16 - CPU

Slot 6:

PCI Express Gen3 x4 - PCH with open-ended connector*

M.2 Slot 1:

M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

M.2 Slot 2:

M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

* Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.

Supported Drive Interfaces

SATA 6 SATA @6Gb/s, supports RAID 0, 1, 5, & 10

Serial Attached SCSI Requires Optional PCIe card



System Technical Specifications

Factory Configured

RAID

SATA RAID 0 Striped Array SATA RAID 1 Mirrored Array SATA RAID 10 Striped/Mirrored

Notes:

Factory integrated Intel® SATA RAID is Microsoft Windows only.

External SATA (eSATA) Supported on all SATA ports configurable with optional eSATA* cable kit

* hot plug / hot swap not supported with eSATA

Network Controller Integrated Intel®

I219LM GbE LAN

Supports the following management functionalities: Intel® AMT11.2, TXT, DASH

1.1, WOL, VLAN, and PXE 2.1

Integrated Intel X722

for 1GbE

Data rates supported: 1000 Mb/s

Compliance IEEE 802.1as/1588v2, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az,

802.3x

Up to 16 UDP/TCP programmable filters

Bus architecture: PCIe 3.0 **UEFI** and **PXE** Boot ROM support Intel iWARP Support (RDMA) Network transfer rates:

1000BASE-T (full-duplex) 2000 Mb/s

Management capabilities: WOL (Excluding Max Power Savings), auto MDI

crossover, PXE, Quad Hash filtering, RSS, Advanced cable

diagnostics

USB Connector(s) Front Front I/O Entry: 4 USB 3.1 Gen1 (Left-most Port has Charging Capability)

Front I/O Premium: 2x USB 3.1 Gen1, 2x USB 3.1 Gen2 Type-C™ (Left-most Port

has Charging Capability)

Charging Ports provide 1.5 Amps @ 5 Volts

Standard USB Type A Ports provide 900mA @ 5 Volts

USB Type C Ports provide 3 Amps @ 5 Volts and adhere to the Power

Delivery 3.0 specification.

Rear 6 USB 3.1 G1 Type A

Internal 1 USB 3.1 G1 single-port header

> 1 USB 2.0 single-port header 1x USB 2.0 dual-port header

Integrated Graphics Nο

HD Integrated Audio

Realtek ALC221

Flash ROM

Yes

CPU Fan Header

One for each CPU socket

Rear Chassis Fan Header Yes Front PCI Fan Header CMOS Battery Holder -Yes

Yes

Lithium

Integrated Trusted

Common Criteria EAL4+ Certified

Platform Module FIPS 140-2 Certified

TPM Certified products list:

https://trustedcomputinggroup.org/membership/certification/tpm-certifiedproducts/

System Technical Specifications

Power Supply Headers Yes **Power Switch, Power** Yes

LED & Hard Drive LED

Header

Clear Password Jumper

Serial Port 1 internal header

Parallel Port No

Keyboard/Mouse USB or PS/2

Hood Lock Header Yes **Hood Sensor Header**

Memory Fan 1 Memory Fan Header per CPU

AUX IN (audio) No

Z6 Required Power Supply Info

1000W 90% Efficient, Custom PSU **Power Supply** (Wide Ranging, Active PFC)

90-269 VAC **Operating Voltage Range**

100-127 VAC 118 VAC **Rated Voltage Range** 200-240 VAC

50-60 Hz 400 Hz **Rated Line Frequency** 47-66 Hz 393-407 Hz **Operating Line Frequency Range**

12 A @ 100-127 VAC

12A @ 118 VAC **Rated Input Current** 6.3 A @ 200-240 VAC

Typical = 2467 btu/hr **Heat Dissipation** (Configuration and software dependent) Maximum = 4112 btu/hr

80x25 mm variable speed **Power Supply Fan**

ENERGY STAR® Qualified (Configuration dependent)

Yes, 90% Efficient

The Z6 G4 1000W power supply efficiency report can be found at this link: 80 PLUS® Compliant https://plugloadsolutions.com/psu_reports/HP_D15-

1KOP1A 1000W ECOS%204838 Report.pdf

FEMP Standby Power Compliant @115V

(<1W in S5 - Power Off) EuP Compliant @ 230V (<0.5 W in S5 – Power Off) **CECP Compliant @ 220V** (<4W in S3 - Suspend to RAM)

Power Consumption in sleep mode

(as defined by ENERGY STAR®) - Suspend to RAM

(Instantly Available PC)

Sensor Header

Built-in Self Test LED Surge Tolerant Full Ranging Power Supply

(withstands power surges up to 2000V)

Integrated in Front User Interface (Power Switch, Power LED, HDD LED,

Yes

Yes

Yes

Yes; Configuration dependent

<= 20W

Yes

Yes

Speaker) Cable



System Technical Specifications

Integrated Gigabit Ethernet Clear CMOS Button

Integrated Intel® I219LM GbE LAN Yes



System Technical Specifications

System Configuration

Example Z6 G4	Processor	1x Intel Xeon	3104 (Six-core)						
Configuration #1	Memory	1x 8GB DDR4-	2666 (Registere	ed DIMM)					
	Graphics	1x NVIDIA Qua	adro P400						
	Disks / Optical	1x 500GB SAT	A 7200 ; 1x Slim	DVD-ROM SA	TA				
	Power Supply	1000W 90% custom PSU							
	Other	NA							
		115 VAC 230 VAC 100 VAC							
Energy Consumption		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled		
	Windows Idle (S0)	54.109		54.	54.586		906		
	Windows Busy Typ(S0)	94.256		94.275		94.043			
	Windows Busy Max (S0)	95.992		95.268		95.643			
	Sleep (S3)	6.219	6.205	6.319	6.306	6.334	6.239		
	Off (S5)	3.354	3.343	3.521	3.341	3.350	3.342		
	Zero Power Mode (ErP)	0.	209	0.388		0.195			
		115	5 VAC	230	VAC	100	VAC		
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled		
(Btu/hr)	Windows Idle (S0)	184	1.619	186	.247	187.339			
	Windows Busy Typ(S0)	321	L.601	321	.666	320	.875		
	Windows Busy Max (S0)	327	7.524	325	.054	326	.334		
	Sleep (S3)	21.219	21.171	21.561	21.516	21.611	21.287		
	Off (S5)	11.444	11.406	12.014	11.399	11.430	11.403		
	Zero Power Mode (ErP)	0.	713	1.3	323	0.665			

Example Z6 G4	Processor	1x Intel Xeon	4108 (Eight-cor	e)				
Configuration #2	Memory	4x 8GB DDR4	-2666 (Register	ed DIMM)				
	Graphics	1x NVIDIA Qu	adro P2000					
	Disks / Optical	2x 1TB SATA 7200 ; 1x Slim DVDRW SATA						
	Power Supply	1000W 90% c	ustom PSU					
	Other	NA						
Energy Consumption		115 VAC 230 VAC					100 VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	
	Windows Idle (S0)	61.661		61.	61.531		354	
	Windows Busy Typ(S0)	168	3.665	167.375		166.535		
	Windows Busy Max (S0)	166	5.097	163.682		169.674		
	Sleep (S3)	7.231	7.177	7.229	7.217	7.324	7.248	
	Off (S5)	3.376	3.366	3.527	3.512	3.354	3.350	
	Zero Power Mode (ErP)	0.	211	0.3	386	0.2	L95	
		115	5 VAC	230	VAC	100	VAC	
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	



System Technical Specifications

(Btu/hr)	Windows Idle (S0)	210.387		209.944		209.340	
	Windows Busy Typ(S0)	575.485		571.084		568.217	
	Windows Busy Max (S0)	576.959		575.543		578.928	
	Sleep (S3)	24.672	24.488	24.665	24.624	24.989	24.730
	Off (S5)	11.519	11.484	12.034	11.983	11.443	11.430
	Zero Power Mode (ErP)	0.	720	1.317		0.665	

Example Z6 G4	Processor	1x Intel Xeon	6136 (Twelve-co	re)				
Configuration #3	Memory	6x 8GB DDR4-	-2666 (Registere	ed DIMM)				
ENERGY STAR	Graphics	1x NVIDIA Qu		,				
QUALIFIED	Disks/Optical	2x 1TB SATA 7	7200 ; 1x Slim D	VDRW SATA				
	Power Supply	1000W 90% c						
	Other	NA						
Energy Consumption			115 VAC 230 VAC 100 VAC					
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	
	Windows Idle (S0)	79	.074	79.	109	79.	938	
	Windows Busy Typ(S0)	324.975		317.991		327.451		
	Windows Busy Max (S0)	328.268		320.296		329.668		
	Sleep (S3)	7.847	7.756	7.878	7.826	7.931	7.852	
	Off (S5)	3.353	3.348	3.535	3.489	3.373	3.355	
	Zero Power Mode (ErP)	0.	206	0.386		0.196		
		115	5 VAC	230	VAC	100	VAC	
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	
(Btu/hr)	Windows Idle (S0)	269	9.801	269	.920	272	.748	
	Windows Busy Typ(S0)	110	8.815	1084	1.985	1117	7.262	
	Windows Busy Max (S0)	112	0.051	1092	2.850	1124.827		
	Sleep (S3)	26.774	26.463	26.880	26.702	27.061	26.791	
	Off (S5)	11.441	11.426	12.061	11.904	11.509	11.447	
	Zero Power Mode (ErP)	0.	703	1.3	317	0.6	0.669	

Example Z6 G4	Processor	2x Intel Xeon 8160 (Dual 24-core)						
Configuration #4	Memory	12x 32GB DDR	4-2666 (Regis	tered DIMM)				
	Graphics	2x NVIDIA Quadro P5000						
	Disks / Optical	4x 2TB SATA 7200 ; 1x Slim DVDRW SATA						
	Power Supply	1000W 90% custom PSU						
	Other	NA						
Energy Consumption		115	VAC	230	VAC	100	VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	
	Windows Idle (S0)	112.388		115.635		112.102		
	Windows Busy Typ(S0)	512.368 490.165 526.905						



System Technical Specifications

	Windows Busy Max (S0)	698.	548	673	465	706	.461
	Sleep (S3)	14.208	13.833	14.698	14.487	15.176	13.886
	Off (S5)	3.511	3.418	3.575	3.570	3.509	3.412
	Zero Power Mode (ErP)	0.2	87	0.3	87	0.2	.72
	115 VAC		230 VAC		100 VAC		
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
(Btu/hr)	Windows Idle (S0)	383.469		394.547		382.492	
	Windows Busy Typ(S0)	1748	.120	1672.443		1797.800	
	Windows Busy Max (S0)	2383	.446	2297.863		2410.445	
	Sleep (S3)	48.478	47.198	50.150	49.430	51.781	47.379
	Off (S5)	11.980	11.662	12.198	12.181	11.973	11.642
	Zero Power Mode (ErP)	0.979		1.321		0.928	

NOTE: Power consumption measurements do not take advantage of the Intel Turbo Boost Technology. As a result, power consumption measurements may be higher.

DECLARED NOISE EMISSIONS

System Configuration	Processor Info	Intel® Xeon® Gold 6130 processor 2.1GHz 12C CPU			
(Entry level)	Memory Info	24GB (3x8GB) DDR4-2666 ECC Memory RDIMMs			
	Graphics Info	1-NVIDIA® Quadro® P400 2GB			
	Disks/Optical	1-500GB SATA 7200RPM 3.5" HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer			
	Power Supply	1000 W			

Declared Noise Emissions		Sound Power	Deskside Sound Pressure		
(in accordance with ISO		(LWAd, bels)	(LpAm, decibels)		
7779 and ISO 9296)	Idle	3.3	15		
	Hard drive Operating (random reads)	3.5	18		

System Configuration	Processor Info	Intel® Xeon® Platinum 8168 processor 2.7GHz 24C CPU				
(Mid-range)	Memory Info	96GB (6x16GB) DDR4-2666 ECC Memory RDIMMs				
	Graphics Info	1-NVIDIA® Quadro® P6000 24GB				
	Disks/Optical	2-4TB 6Gb/s 7200RPM SATA HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer				
	Power Supply	1000 W				

Declared Noise Emissions		Sound Power	Deskside Sound Pressure
(in accordance with ISO		(LWAd, bels)	(LpAm, decibels)
7779 and ISO 9296)	Idle	3.8	23

System Technical Specifications

Hard drive Operating	3.9	23
(random reads)		

System Configuration	Processor Info	2-Intel® Xeon® Gold 6136 processor 3.0GHz 12C CPU	
(High end)	Memory Info	192GB (12x16GB) DDR4-2666 ECC Memory RDIMMs	
	Graphics Info	1-NVIDIA® Quadro® P6000 24GB	
	Disks/Optical	2-4TB 6Gb/s 7200RPM SATA HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer	
	Power Supply	1000 W	

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.8	23
	Hard drive Operating (random reads)	3.9	24

ENVIRONMENTAL DATA

Environmental Requirements

Temperature Operating: 5° to 35° C (40° to 95° F)

Non-operating: -40° to 60° C (-40° to 140° F)

Humidity Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb

Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb

Maximum Altitude Operating: 3,048 m (10,000 feet)

Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation

Non-operating: 9,144 m (30,000 feet)

Shock (non-repetitive) Operating: ½-sine: 40g, 2-3ms (~62 cm/sec)

Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g)

square: 422 cm/s, 20g

Vibration

Operating random: 0.5g (rms), 5-300 Hz, up to $0.0025g^2/Hz$ Non-operating random: 2.0g (rms), 5-500 Hz, up to $0.0150 g^2/Hz$

Physical Security and Serviceability

Access Panel Tool-less

Includes system board and memory information.

Optical Drive Tool-less, no carrier or rails required

Hard Drives Tool-less

System Technical Specifications

Optional 5.25" external bay carriers

Expansion Cards Tool-less

Processor Socket 1st socket on main system board. 2nd socket on optional 2nd CPU/Memory Module.

Blue User Touch Points Yes, on primary serviceable components.

Color-coordinated Cables Yes

and Connectors

Tool-less Memory

Torx T15 screws System Board

2nd CPU/Memory Module: Tool-less

Front of Computer LEDs Dual Color Power/Failure LED = Yes

HDD Activity LED = Yes

Configuration Record SW Yes

Over-Temp Warning on

Screen

Yes, at POST screen on reboot

Restore CD/DVD Set

Yes, also acts as a reset switch when held for 4 seconds.

Dual Function Front

Power Switch

Padlock Support Yes

Cable Lock Support Kensington Cable Lock (optional): Prevents entire system theft and system access. 3mm x 7mm slot at

rear of system

No

Universal Chassis Clamp

Solenoid Lock and Hood

Lock Support

Sensor

Access Panel Solenoid Lock: Yes (optional). Activated remotely to prevent system entry.

Yes, restores the computer to its original factory shipping image; can be obtained via HP Support.

Access Panel Intrusion Sensor: Yes (optional).

Removable Media

Write/Boot Control

Yes, user can prevent the workstation from writing to or booting from removable media.

Power-On Password

Yes, prevents an unauthorized person from booting up the workstation

Setup Password

Yes, prevents an unauthorized person from changing the workstation configuration

3.3V Aux Power LED on

System PCA

Yes

Yes

NIC LEDs (integrated) (Green & Amber)

CPUs and Heatsinks

CPU heatsink removal requires a T-30 Torx screwdriver.

Power Supply Diagnostic

LED

Yes

Yes **Front Power Button** Yes **Rear Power Button**

Front Power LED Yes, white (normal), red (fault)

Front Hard Drive Activity Yes, white

LED

Front ODD Activity LED Yes on device

Internal Speaker Yes



System Technical Specifications

System/Emergency ROM Recovers corrupted system BIOS.

Flash Recovery

Cooling Solutions Air cooled forced convection

1 - 80 mm x 80 mm x 25 mm (non-serviceable) **Power Supply Fans**

CPU Heatsink Fan 1st CPU: 1 - 80mm

Optional 2nd CPU: 1 - 60mm x 25mm

Front memory fan: 1 – 80mm x 25mm **Memory Fan**

Memory duct blower: 1 – 90mm x 25mm 2nd CPU/Memory Module: 1 - 60mm x 25mm

Chassis Fans Front chassis fan: 1 - 120mm x 25mm

Rear chassis fan: 1 - 120mm x 25mm

HP Vision Diagnostics

Offline Edition

HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing ESC then F2 upon the PC reboot, and is

available as a download from HP Support.

Access Panel Key Lock ACPI-Ready Hardware Yes, side panel barrel keylock (optional from the factory only) Advanced Configuration and Power Management Interface (ACPI).

Allows the system to wake from a low-power mode.

Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system

Trusted Platform Module Integrated Infineon TPM 2.0. TCG and FIPS 140-2 Certified

Chip

Integrated Chassis Yes, Front handle and dedicated rear recess

Handles

Power Supply

Requires T15 Torx or flat blade screwdriver

PCIe Card Retention Yes, tool-less

Rear (all)

Middle (full-height cards)

Front (full-length cards with extender)

Flash ROM Yes

Diagnostic Power Switch Yes

LED on board

Clear CMOS Button

Clear Password Jumper Yes Yes **CMOS Battery Holder** Yes

DIMM Connectors Yes

BIOS

BIOS 32-bit Services Standard BIOS 32-bit Service Directory Proposal v0.4

Full BIOS support for PCI Express through industry standard interfaces. PCI 3.0 Support

ATAPI ATAPI Removable Media Device BIOS Specification Version 1.0.

BBS BIOS Boot Specification v1.01.

WMI Support WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI

is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model

(CIM) and WBEM specifications.

BIOS Boot Spec 1.01+

Provides more control over how and from what devices the workstation will boot.

BIOS Power On Users can define a specific date and time for the system to power on.



System Technical Specifications

ROM Based Computer

Review and customize system configuration settings controlled by the BIOS.

Setup Utility (F10) System/Emergency ROM

Recovers system BIOS in corrupted Flash ROM.

Flash Recovery with Video

Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). **Replicated Setup**

BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed

without entering Computer Configuration Utility (F10 Setup).

SMBIOS Boot Control System Management BIOS 2.8, for system management information. Disables the ability to boot from removable media on supported devices.

Memory Change Alert

Alerts management console if memory is removed or changed.

Thermal Alert

Monitors the temperature state within the chassis. Three modes:

NORMAL - normal temperature ranges.

• ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid

shutdown or provide for a smoother system shutdown.

• SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer

without warning before hardware component damage occurs.

Remote ROM Flash

Provides secure, fail-safe ROM image management from a central network console.

ACPI (Advanced

Allows the system to enter and resume from low power modes (sleep states).

Configuration and Power Management Interface)

Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without

affecting other elements of the system.

Supports ACPI 5.0 for full compatibility with 64-bit operating systems.

Ownership Tag

A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.

Shutdown

Remote Wakeup/Remote System administrators can power on, restart, and power off a client computer from a remote location.

Instantly Available PC

(Suspend to RAM - ACPI

sleep state S3)

Allows for very low power consumption with quick resume time.

Remote System Installation via F12 (PXE 2.1) (Remote Boot from

Server)

Allows a new or existing system to boot over the network and download software, including the operating system.

ROM revision levels

Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS and WMI) so that management SW applications can use

and report this information.

System board revision

level

Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.

Start-up Diagnostics (Power-on Self-Test) Assesses system health at boot time with selectable levels of testing.

Auto Setup when new hardware installed

System automatically detects addition of new hardware.

Keyboard-less Operation The system can be booted without a keyboard.

Localized ROM Setup

Common BIOS image supports System Configuration Utility (F10 Setup) menus in 14 languages with local

keyboard mappings.

The user or MIS to set a unique tag string in non-volatile memory. **Asset Tag**

Per-slot Control Adaptive Cooling Pre-boot Diagnostics Industry Standard

Specification Support

Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. Control parameters are set according to detected hardware configuration for optimal acoustics.

(Pre-video) critical errors are reported via beeps and blinks on the power LED.

System Technical Specifications

Industry Standard Revision Supported by the BIOS

UEFI Specification 2.6

Revision

ACPI Advanced Configuration and Power Management Interface, Version 5.0

ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b

CD Boot "El Torito" Bootable CD-ROM Format Specification Version 1.0

EDD - Enhanced Disk Drive Specification Version 1.1

- BIOS Enhanced Disk Drive Specification Version 3.0

EHCI Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0

PCI Local Bus Specification, Revision 2.3

PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7

PCI Express Base Specification, Revision 2.0

PCI Express Base Specification, Revision 3.0

PMM POST Memory Manager Specification, Version 1.01

SATA Serial ATA Specification, Revision 1.0a

Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0

SPD PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B

TPM Trusted Platform Module (TPM) 2.0 (Infineon SLB 9670)

Common Criteria EAL4+ Certified

FIPS 140-2 Certification

TCG TPM Certified products list:

http://www.trustedcomputinggroup.org/certification/tpm-certified-products/

UHCI Universal Host Controller Interface Design Guide, Revision 1.1

USB Universal Serial Bus Revision 1.1 Specification

Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 Specification

SMBIOS System Management BIOS Reference Specification, Version 2.8

External BIOS simulator found at: http://csrsml.itcs.hp.com/

Social and Environmental Responsibility

Eco-Label Certifications & This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

See Will one of more or mese marks.

- ENERGY STAR® (energy-saving features available on selected configurations-Windows only)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program
- The ECO declaration (TED)

The Z6 G4 is registered EPEAT® Silver in the US and Canada. EPEAT® registration varies by country. See http://www.epeat.net for registration status by country. Search keyword generator on HP's 3rd party

option store for solar generator accessories at http://www.hp.com/go/options

The battery in this product complies with EU Directive 2006/66/EC

Battery mass: 3g

Battery type: Lithium Metal



Batteries

System Technical Specifications

The battery in this product does not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40ppm by weight

Restricted Material Usage This product meets the material restrictions specified in HP's General Specification for the Environment.

HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis

Low Halogen Statement

This product is low-halogen except for power cords, external cables and peripherals. Service parts obtained after purchase may not be low-halogen.

End-of-Life Management and Recycling

HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.

HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

Sustainability Report

Eco-label certifications:

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

ISO 14001 certificate:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html

Additional Information

- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. Product Disassembly Instructions
- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.

Packaging

HP Workstation product packaging meets the HP's General Specification for the Environment

- Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment
- Does not contain ozone-depleting substances (ODS)
- Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed
- Maximizes the use of post-consumer recycled content materials in packaging materials
- All packaging material is recyclable
- All packaging material is designed for ease of disassembly
- Reduced size and weight of packages to improve transportation fuel efficiency
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting
- A multi-unit eco packaging option is available to institutional customers that uses less packaging material or has a lower volume footprint than conventional single-unit packaging. Please contact your sales representative for additional details.

Packaging Materials Internal

Cushions and plastic bags made of low density polyethylene (LDPE).



System Technical Specifications

External

Outer carton, accessories carton, and insert made of corrugated paper board.

Manageability

Industry Standard Specifications

This product meets the following industry standard specifications for manageability functionality:

• DASH 1.1 (via Intel® LAN on motherboard)

Intel® Active Management Intel® Active Management Technology (AMT) 11.2x Technology (AMT)

An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 11.2x includes the following advanced management functions:

- Power Management (on, off, reset, graceful shutdown, sleep and hibernate)
 - Support in Max Power Savings (Shutdown and Hibernate Modes)
- Hardware Inventory (includes BIOS and firmware revisions)
- Hardware Alerting
- Agent Presence
- System Defense Filters
- Serial Over LAN (SOL)
- USB Redirect (Media Redirection)
- ME Wake-on-LAN (WOL), even with Maximum Power Savings Enabled
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the system connects to the IT or service provider console for maintenance.
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration
- Management Engine (ME) firmware roll back
- Local Time Sync to UTC
- Remote Memory Dump Command Creates memory dump for debug

Intel® vPro™ Technology

The HP Z6 G4 Workstation supports Intel® vPro™ technology when configured as outlined below:

- Intel[®] Xeon[®] processor Scalable Family
- Intel® C622 chipset
- Intel® I219LM GbE LAN

Remote Manageability Software Solutions

The HP Z6 G4 Workstation is supported on the following remote manageability software consoles:

- LANDesk Management Suite (HP recommended solution)
- Microsoft System Center Configuration Manager
- HP Client Automation Enterprise

For questions or support for manageability needs, please visit http://www.hp.com/go/clientmanagement

System Software Manager For questions or support for SSM, please visit: http://www.hp.com/go/ssm



System Technical Specifications

Service, Support, and Warranty

On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. **NOTE 2:** On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location.

Product Change Notification

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.

Stable & Consistent Offerings

Global Series SKUs	As part of its commitme	ent to hardware, software, and solution innovation, HP is proud to introduce this	
	configuration stability to HP Workstation customers. HP Stable & Consistent e foundation of a carefully chosen set of hardware and software designed and HP Z Workstation platforms through their end of life. These components and Workstation platform compatibility are outlined in this section.		
Stable & Consistent Offerings	HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.		
Processors	Product #	Offering	
	2DL32AV	Intel® Xeon® Gold 6128 processor	
	2DL32AV, 1XM44AA	Intel® Xeon® Gold 6128 2 nd processor	
	2DL22AV	Intel® Xeon® Silver 4114 processor	
	2DL22AV, 1XM49AA	Intel® Xeon® Silver 4114 2nd processor	
	2DL18AV	Intel® Xeon® Silver 4108 processor	
	2DL18AV, 1XM51AA	Intel® Xeon® Silver 4108 2 nd processor	
Hard Drives	Product #	Offering	
	Z5H22AV, LQ037AA	1TB SATA 7200 RPM 3.5" HDD	
Graphics	Product #	Offering	
	2TF08AA	AMD Radeon™ Pro WX 3100 4GB Graphics	
Memory	Product #	Offering	
	TBD	TBD	
Optical and Removable	Product #	Offering	



Storage

TBD

TBD

Technical Specifications - Processors

Intel® Xeon® W-3200 Series CPU

Intel® Xeon® W-3275 2.5 2933 28C processor

Intel® Xeon® W-3265 2.7 2933 24C processor

Intel® Xeon® W-3245 3.2 2933 16C processor

Intel® Xeon® W-3235 3.3 2933 12C processor

Intel® Xeon® W-3225 3.7 2666 8C processor

Intel® Xeon® W-3223 3.5 2666 8C processor

Intel® Xeon® Scalable CPU

Intel® Xeon® Platinum 8280 processor

Intel® Xeon® Platinum 8260 processor

Intel® Xeon® Gold 6258R processor

Intel® Xeon® Gold 6254 processor

Intel® Xeon® Gold 6252 processor

Intel® Xeon® Gold 6248R processor

Intel® Xeon® Gold 6248 processor

Intel® Xeon® Gold 6246R processor

Intel® Xeon® Gold 6244 processor

Intel® Xeon® Gold 6242R processor

Intel® Xeon® Gold 6242 processor

Intel® Xeon® Gold 6240R processor

Intel® Xeon® Gold 6240Y processor

Intel® Xeon® Gold 6240 processor

Intel® Xeon® Gold 6238R processor

Intel® Xeon® Gold 6238 processor

Intel® Xeon® Gold 6234 processor

Intel® Xeon® Gold 6230R processor

Intel® Xeon® Gold 6230 processor

Intel® Xeon® Gold 6226R processor

Intel® Xeon® Gold 6226 processor

Intel® Xeon® Gold 6154 processor

Intel® Xeon® Gold 6136 processor

Intel® Xeon® Gold 6134 processor

Intel® Xeon® Gold 6132 processor

Intel® Xeon® Gold 6128 processor

Intel® Xeon® Gold 5222 processor

Intel® Xeon® Gold 5220R processor

Intel® Xeon® Gold 5220 processor

Intel® Xeon® Gold 5218R processor

Intel® Xeon® Gold 5218 processor

Intel® Xeon® Gold 5215 processor

Intel® Xeon® Gold 5118 processor

Intel® Xeon® Gold 4216 processor



Technical Specifications - Processors

Intel® Xeon® Gold 4215R processor

Intel® Xeon® Gold 4215 processor

Intel® Xeon® Gold 4214R processor

Intel® Xeon® Gold 4214Y processor

Intel® Xeon® Gold 4214 processor

Intel® Xeon® Gold 4210R processor

Intel® Xeon® Gold 4210 processor

Intel® Xeon® Gold 4208 processor

Intel® Xeon® Silver 4114 processor

Intel® Xeon® Silver 4112 processor

Intel® Xeon® Silver 4108 processor

Intel® Xeon® Bronze 3206R processor

Intel® Xeon® Bronze 3204 processor

Intel® Xeon® Bronze 3106 processor



STORAGE/HARD DRIVES

HP SAS (Serial Attached

SCSI) Hard Drives for HP Workstations

HP 300GB SAS 15K SFF

HDD

Capacity

300GB

Height Width

5.9 in; 15 cm

Media Diameter

Up to 1200 MB/s (SAS single port)*

3.5 in; 8.9 cm

2.0ms *

Interface

12Gb/s SAS

Average

Synchronous Transfer

Rate (Maximum)

128MB

Seek Time (typical reads,

includes controller

overhead, including

settling)

Buffer

Rotational Speed 15K rpm

41° to 131° F (5° to 55° C) **Operating Temperature**

*Actual performance may vary.

SATA (Serial ATA) Hard Drives for HP Workstations 500GB SATA 7200 rpm 6Gb/s 3.5" HDD
 Capacity
 500GB

 Height
 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s*

Rate (Maximum)

Buffer 16MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2 ms*Average
Full Stroke11 ms*21 ms*

Rotational Speed 7,200 rpm Logical Blocks 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 1TB

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Up to 600 MB/s*

Physical Size 4 in; 10.17 cm

2 ms*

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Buffer 64MB

Cache Adaptive
Seek Time (typical reads, Single Track

includes controller overhead, including settling)

Average 11 ms*
Full Stroke 21 ms*

Rotational Speed 7,200 rpm

Operating Temperature 41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD CMR

Capacity 2.0TB

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer Up to 600 MB/s*

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads,
includes controllerSingle Track1.0 ms*Average11 ms*



^{*}Actual performance may vary.

^{*}Actual performance may vary.

overhead, including

Full Stroke

18 ms*

1.2 ms*

12 ms*

21 ms*

Not Specified*

settling)

Rotational Speed 7,200 rpm 3,907,029,168 **Logical Blocks**

Operating Temperature 41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD SMR

Capacity 2.0TB

Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm

Up to 600 MB/s*

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer

Rate (Maximum)

64MB

Buffer Seek Time (typical reads, **Single Track**

includes controller **Average** overhead, including **Full Stroke**

settling)

Rotational Speed 7,200 rpm **Logical Blocks** 3,907,029,168

41° to 140° F (5° to 60° C) **Operating Temperature**

3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

3.0TB Capacity

1 in; 2.54 cm Height

Width **Media Diameter** 3.5 in; 8.9 cm

> **Physical Size** 4.0 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 6.0 Gb/s*

Rate (Maximum)

Buffer

settling)

64MB

Seek Time (typical reads, **Single Track** 0.6 ms* includes controller **Average** 11 ms*

overhead, including **Full Stroke**

Rotational Speed 7,200 rpm

41° to 140° F (5° to 60° C) **Operating Temperature**

^{*}Actual performance may vary.

^{*}Actual performance may vary.

^{*}Actual performance may vary.

1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) Capacity 1TB
Protocol SATA
Form Factor 3.5"
Controller AHCI

Reliability (MTBF) 2.0M hours
Rated Power On Hours 8760/yr
Annualized Failure Rate <0.62%

(based on Rated POH)

Rated for 24/7/365 YES

operation

Physical Size (Height)1 in; 2.54 cmPhysical Size (Width)4 in; 10.17 cmMedia Diameter3.5 in; 8.9 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Buffer

128MB

Up to 600MB/s*

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.32ms*Average
Full Stroke7.45ms*

Operating Temperature

41° to 140° F (5° to 60° C)

Performance Sequential Read up to 226MB/s*
Sequential Write up to 226MB/s*

Enterprise Class Features High Reliability



^{*}Actual performance may vary.

4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)

4TB Capacity

Height 0.275 in; 0.7 cm

Width **Media Diameter** 2.5 in; 6.36 cm

> **Physical Size** 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Up to 600MB/s*

Buffer 128MB

0.7ms* Seek Time (typical reads, **Single Track** includes controller **Average** 8.5ms* overhead, including 15.7ms* **Full Stroke**

settling)

Rotational Speed 7,200 rpm

Operating Temperature 32° to 140° F (0° to 60° C)

*Actual performance may vary.

500GB SATA 7.2K SED SFF Capacity **HDD**

500GB

0.275 in; 0.7 cm Height

Width **Media Diameter** 2.5 in; 6.36 cm

Physical Size 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s) **Synchronous Transfer** Up to 600MB/s*

Rate (Maximum)

32MB

Buffer Seek Time (typical reads, **Single Track**

includes controller overhead, including

settling)

1ms* **Average** 4.2ms*

25ms (typical)* **Full Stroke**

Rotational Speed 7,200 rpm

Operating Temperature 32° to 140° F (0° to 60° C)

*Actual performance may vary.



SATA SSDs for HP	•
Workstations	

HP 256GB SATA 6Gb/s SSD

Protocol SATA
Form Factor 2.5"
Controller AHCI
NAND Type 3D TLC

Endurance 192TBW (TB Written)

Reliability (MTTF) 1.5M hours

Physical Size (Height) 0.28 in; 0.7 cm

Physical Size (Width) 2.5 in; 6.36 cm

Interface SATA 6Gb/s

Synchronous Transfer Rate Up to 600MB/s*

(Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 530MB/s (max)*

Sequential Write 500MB/s (max)*
Random Read 95K IOPS (max)*
Random Write 83K IOPS (max)*

HP 256GB SATA 6Gb/s SED Opal 2 SSD

Capacity256GBProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLC

Endurance 192TBW (TB Written)

Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterface6Gb/s SATA

Synchronous Transfer Rate Up to 550MB/s (Sequential Read)*

(Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 530MB/s*

Sequential Write 500 MB/s*
Random Read 95K IOPS*
Random Write 83K IOPS*

Self-Encrypting Drive

Support

OPAL 2

*Actual performance may vary.

HP 512GB SATA 6Gb/s

SSD

Capacity 512GB
Protocol SATA
Form Factor 2.5"
Controller AHCI



^{*}Actual performance may vary.

NAND Type 3D TLC

Endurance 388TBW (TB Written)

Reliability (MTTF) 1.5M hours

Physical Size (Height) 0.28 in; 0.7 cm

Physical Size (Width) 2.5 in; 6.36 cm

Interface SATA 6Gb/s

Synchronous Transfer Rate Up to 550MB/s (Sequential Read)*

(Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 530 MB/s*

Sequential Write500 MB/s*Random Read95K IOPS*Random Write83K IOPS*

HP 512GB SATA SED SSD

Capacity 512GB
Protocol SATA
Form Factor 2.5"
Controller AHCI
NAND Type 3D TLC

Endurance 388TBW (TB Written)

Reliability (MTTF) 1.5M hours
Physical Size (Height) 0.28 in; 0.7 cm
Physical Size (Width) 2.5 in; 6.36 cm
Interface SATA 6Gb/s
Synchronous Transfer Rate Up to 600MB/s*

(Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 530 MB/s*

Sequential Write 500 MB/s*
Random Read 95K IOPS*
Random Write 83K IOPS*

OPAL 1 and 2

Self-Encrypting Drive

Support

*Actual performance may vary.

HP 1TB SATA 6Gb/s SSD Capacity

Capacity 1TB
Protocol SATA
Form Factor 2.5"
Controller AHCI
NAND Type 3D TLC

Endurance 400TBW (TB Written)

Reliability (MTTF) 1.5M hours **Physical Size** (Height) 0.28 in; 0.7 cm



^{*}Actual performance may vary.

Physical Size (Width) 2.5 in; 6.36 cm Interface SATA 6Gb/s

Synchronous Transfer Rate Up to 550MB/s (Sequential Read)*

(Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 530 MB/s*

Sequential Write 500 MB/s*
Random Read 95K IOPS*
Random Write 83K IOPS*

HP 2TB SATA 6Gb/s SSD

Capacity2TBProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLC

Endurance 400TBW (TB Written)

Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/s

Synchronous Transfer Rate Up to 550MB/s (Sequential Read)*

(Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 530 MB/s*

Sequential Write 500 MB/s *
Random Read 95K IOPS*
Random Write 83K IOPS*

HP Enterprise Class 240GB SATA SSD

Capacity240GBProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLC

Endurance 2,200TBW (TB Written)

Reliability (MTTF) 2.0M hours

Physical Size (Height) 0.28 in; 0.7 cm

Physical Size (Width) 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer Rate Up to 600MB/s*

(Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 540 MB/s*

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Sequential Write	310 MB/s*
Random Read	93K IOPS*
Random Write	48K IOPS*

Enterprise Class Features High Endurance NAND

Power Loss Protection
End-to-End Data Protection

HP Enterprise Class 480GB SATA SSD

Capacity480GBProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLC

Endurance 4,400TBW (TB Written)

Reliability (MTTF) 2.0M hours

Physical Size (Height) 0.28 in; 0.7 cm

Physical Size (Width) 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer Rate Up to 600MB/s*

(Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 540 MB/s*

Sequential Write 460 MB/s*
Random Read 93K IOPS*
Random Write 74K IOPS*

Enterprise Class Features High Endurance NAND

Power Loss Protection End-to-End Data Protection

Performance PCIe SSDs for HP Workstations

HP Z Turbo Drive 256GB M.2 2280 TLC SSD Capacity 256GB PCle **Protocol** Form Factor M.2 Controller NVMe 3D TLC **NAND Type SED Support** Opal 2 **Endurance** 200TB Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s *

Sequential Write 2200 MB/s *
Random Read 240K IOPS *
Random Write 480K IOPS *

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

*Actual performance may vary.

HP ZTurbo Drive 512GB M.2 2280 TLC SSD

Capacity 512GB PCle **Protocol Form Factor** M.2 Controller **NVMe NAND Type** 3D TLC **SED Support** Opal 2 **Endurance** 300TB Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 2900 MB/s*
Random Read 460 K IOPS*
Random Write 500K IOPS*

HP ZTurbo Drive 1TB M.2 Capacity 2280 TLC SSD Protocol

Capacity 1TB
Protocol PCle
Form Factor M.2
Controller NVMe
NAND Type 3D TLC
SED Support Opal 2
Endurance 400TB
Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 3000 MB/s*
Random Read 580K IOPS*
Random Write 500K IOPS*

HP ZTurbo Drive 2TB M.2 Capacity 2280 TLC SSD Protocol

Capacity 2TB
Protocol PCle
Form Factor M.2
Controller NVMe
NAND Type 3D TLC
SED Support Opal 2
Endurance 500TB
Reliability (MTTF) 1.5M hours



^{*}Actual performance may vary.

^{*}Actual performance may vary.

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3300 MB/s*

Sequential Write 2400 MB/s*
Random Read 500K IOPS*
Random Write 440K IOPS*

HP Z Turbo Drive Quad Capacity
Pro 2x256GB PCIe TLC SSD Protocol

Capacity 512GB Protocol PCIe

Form Factor PCIe Card, Full Height PCIe Slot

Controller NVMe

NAND Type 3D TLC

SED Support Opal 2

Endurance 200TB

Reliability (MTBF) 1.5M hours

InterfacePCIe Gen3 x4 architectureOperating Temperature32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 2200 MB/s*
Random Read 240K IOPS*
Random Write 480K IOPS*

HP Z Turbo Drive Quad Capacity
Pro 2x512GB PCIe TLC SSD Protocol

Capacity 1TB
Protocol PCle

Form Factor PCIe Card, Full Height PCIe Slot

Controller NVMe
NAND Type 3D TLC
SED Support Opal 2
Endurance 300TB
Reliability (MTBF) 1.5M hours

Interface PCIe Gen3 x4 architecture
Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 2900 MB/s*
Random Read 460 K IOPS*
Random Write 500K IOPS*

HP Z Turbo Drive Quad Pro Capacity 2TB

2x1TB PCIe TLC SSD Protocol PCIe

Form Factor PCIe Card, Full Height PCIe Slot

^{*}Actual performance may vary.

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Controller NVMe **NAND Type** 3D TLC **SED Support** Opal 2 **Endurance** 400TB

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

> **Sequential Write** 3000 MB/s* **Random Read** 580K IOPS* **Random Write 500K IOPS***

HP Z Turbo Drive Dual Pro Capacity 256GB **256GB SSD Protocol PCIe**

> **Form Factor** M.2 in Half-height, half-length card

Controller NVMe **NAND Type** 3D TLC

200TBW (TB Written) **Endurance**

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

> **Sequential Write** 2200 MB/s* **Random Read** 240K IOPS* **Random Write**

480K IOPS*

HP Z Turbo Drive Dual Pro Capacity 512GB **512GB SSD Protocol PCle**

> Form Factor M.2 in Half-height, half-length card

Controller NVMe **NAND Type** 3D TLC

300TBW (TB Written) **Endurance**

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

> 2900 MB/s* **Sequential Write Random Read** 460 K IOPS* **Random Write 500K IOPS***



^{*}Actual performance may vary.

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

HP Z Turbo Drive Dual Pro Capacity 1TB

1TB SSD Protocol PCle

Form Factor M.2 in Half-height, half-length card

ControllerNVMeNAND Type3D TLC

Endurance 400TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 3000 MB/s*
Random Read 580K IOPS*
Random Write 500K IOPS*

HP Z Turbo Drive Dual Pro Capacity
2TB SSD Protocol

Protocol PCIe

Form Factor M.2 in Half-height, half-length card

2TB

Controller NVMe NAND Type 3D TLC

Endurance 500TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 3000 MB/s *
Random Read 600K IOPS*
Random Write 500K IOPS*

Mainstream PCle SSDs for HP 256GB M.2 2280 TLC HP Workstations SSD

Capacity 256GB
Protocol PCle
Form Factor M.2
Controller NVMe
NAND Type 3D TLC
Endurance 200TB
Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3100 MB/s *

Sequential Write 1400 MB/s * Random Read 200 K IOPS *

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Random	Write	320 K IOPS ³
Namaom	VVIICE	320

*Actual performance may vary.

HP 512GB M.2 2280 TLC

SSD

Capacity 512GB
Protocol PCle
Form Factor M.2
Controller NVMe
NAND Type 3D TLC
Endurance 300TB
Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3300 MB/s*

1TB

Sequential Write 2500 MB/s*
Random Read 225 K IOPS*
Random Write 430 K IOPS*

HP 1TB M.2 2280 TLC SSD Capacity

ProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLCEndurance400TBReliability (MTBF)1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3300 MB/s*

2TB

Sequential Write 2500 MB/s*
Random Read 400 K IOPS*
Random Write 440 K IOPS*

HP 2TB M.2 2280 TLC SSD Capacity

Protocol PCIe
Form Factor M.2
Controller NVMe
NAND Type 3D TLC
Endurance 500TB
Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3300 MB/s*

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Sequential Write 2700 MB/s*
Random Read 430 K IOPS*
Random Write 500 K IOPS*

*Actual performance may vary.

Intel® 905p Series AIC PCIe SSD

Intel® 905p Series AIC 280GB PCIe SSD

Capacity 280GB
Protocol PCle

Form Factor PCIe Card, Half Height

Controller NVMe
NVM Type 3DXPoint

Endurance 5.11 PBW (PB Written)

Reliability (MTBF) 1.6M hours

Operating Temperature 32° to 185° F (0° to 85° C)

Performance Sequential Read 2730 MB/s*

Sequential Write 2280 MB/s*
Random Read 587K IOPS*
Random Write 559K IOPS*

*Actual performance may vary.

Intel® 905p Series AIC 480GB PCIe SSD

Capacity 480GB Protocol PCle

Form Factor PCIe Card, Half Height

Controller NVMe
NVM Type 3DXPoint

Endurance 8.76 PBW (PB Written)

Reliability (MTBF) 1.6M hours

Operating Temperature 32° to 185° F (0° to 85° C)

Performance Sequential Read 2710 MB/s*

Sequential Write 2280 MB/s*
Random Read 582K IOPS*
Random Write 561K IOPS*

*Actual performance may vary.

Intel® Optane™ DC Persistent Memory

Intel® Optane™ DC Capacity
Persistent Memory 128GB Protocol
Module

Capacity 128GB
Protocol DDR-T
Form Factor DDR4
Controller NVMe
NVM Type 3DXPoint

Endurance 292 PBW (256B Sequential Write)

91 PBW (64B Sequential Write)

Reliability (MTBF) 2M hours

Operating Temperature 32° to 185° F (0° to 85° C)



Performance Sequential Read 6800 MB/s*

Sequential Write 1850 MB/s*

*Actual performance may vary.



Technical Specifications - Hard Drive Controllers

HARD DRIVE CONTROLLERS

Microsemi SmartHBA2100-4i4e SAS

Card

PCI Bus 8 lanes, PCI Express 3.0

RAID Levels Offers Integrated RAID (0, 1, and 10)
PCI Data Burst Transfer Half Duplex x8, PCIe, 8000 MB/s

Rate

11 11 Duplex x8, FCIE, 8000 WB/3

SAS Bandwidth Half Duplex

PCI Card Type 3.3V Add-in Card PCI Voltage $12 \text{ V} \pm 10\%$

PCI Power 9.8W typical, Airflow min 200 LFM

Bracket Full height and low profile
Certification Level PCI Express 3.0 compliant

SAS Processor Microsemi SmartIOC 2100 SAS IO Controller Internal Connectors One x4 internal mini-SASHD (SFF-8643)

External Connectors One x4 external mini-SASHD (SFF-8644)

Maximum Number of SCSI 256 Non-RAID SAS/SATA devices

Devices

LED Indicators Connector for Drive Activity Light

NOTE: RAID 5 is not supported on MicroSemi 2100-4i4e 8-port SAS 12Gb/s

1200 MB/s per lane

RAID Card



GRAPHICS

NVIDIA® Quadro® P400

2GB Graphics

Form Factor Dimensions: 2.713" H x 5.7" L

Single Slot, Low Profile

Cooling: Active Weight: 129 grams

Graphics Controller NVIDIA® Quadro® P400 Graphics Card

GPU: 256 NVIDIA® CUDA® cores

Max Power: 30 Watts

Bus Type PCI Express 3.0 x16

Memory Size: 2 GB GDDR5, 2000 MHz

Memory Interface: 64-bit Memory Bandwidth: 32 GB/s

Connectors 3mDP Outputs

Maximum Resolution DisplayPort™ 1.4:

- up to 3x 5120 x 2880 x 24 bpp @ 60Hz- supports Multi-Stream Transport (MST)

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output 3 mDP Connectors

Shading Architecture Full Microsoft DirectX® 12 Shader Model 5.1

Supported Graphics APIs OpenGL® 4.5

DirectX® 12 Vulkan™ 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute , OpenCL™

Available Graphics Drivers Microsoft Windows 10

Microsoft Windows 7 Professional 64-bit

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

NVIDIA® Quadro® P620

2GB Graphics

Form Factor Dimensions: 2.713" H x 5.7" L

Single Slot, Low Profile Cooling: Active Weight: 129 grams

Graphics Controller NVIDIA® Quadro® P620 Graphics Card

GPU: 512 CUDA cores Max Power: 40 Watts

Bus Type PCI Express 3.0 x16

Memory Size: 2 GB GDDR5, 2000 MHz

Technical Specifications - Graphics

Memory Interface: 128-bit

Memory Bandwidth: 64 GB/s

Connectors 4mDP Outputs * **Maximum Resolution** DisplayPort™ 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output 4 mDP Connectors

Shading Architecture Full Microsoft DirectX 12 Shader Model 5.1

Supported Graphics APIs OpenGL 4.5

DirectX 12 Vulkan 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute, OpenCL

Available Graphics Drivers Windows10 (64-bit)

Windows 7 Professional 64-bit

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes *P620 only have mini-DisplayPort™ (mDP) video ports.

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters

included

After market option kit:Two mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or

Option Kit accessories:

- 2MY05AA - HP miniDP-to-DP Adapter Cables

- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

NVIDIA® T400 2GB Graphics **Form Factor** Dimensions: 2.713" H x 6.137" L

Single Slot, Low Profile

Weight: 124g

Graphics Controller NVIDIA® T400 Graphics Card

GPU: 384 CUDA cores Power: 30 Watts Cooling: Active

Bus Type PCI Express 3.0 x16

Memory Size: 2 GB GDDR6

Memory Interface: 64-bit Memory Bandwidth: 80 GB/s



Technical Specifications - Graphics

Connectors 3x mDP

Maximum Resolution 3x 5120 x 2880 x 24 bpp @ 60Hz

Supported Graphics APIs OpenGL 4.5

DirectX 12 Vulkan 1.0

API support includes: CUDA, OpenCL 1.x

Available Graphics Drivers Windows 10

Linux

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® T600 4GB Graphics

Form Factor Dimensions: 2.713" H x 6.137" L

Single Slot, Low Profile

Weight: 130g

Graphics Controller NVIDIA® T600 Graphics Card

GPU: 640 CUDA cores Power: 40 Watts Cooling: Active

Bus Type PCI Express 3.0 x16

Memory Size: 4 GB GDDR6

Memory Interface: 128-bit Memory Bandwidth: 160 GB/s

Connectors 4x mDP

Maximum Resolution 4x 5120 x 2880 x 24 bpp @ 60Hz

Supported Graphics APIs OpenGL 4.5

DirectX 12 Vulkan 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute , OpenCL

Available Graphics Drivers Windows 10

Linux

HP qualified drivers may be preloaded or available from the HP support

Web site

http://welcome.hp.com/country/us/en/support.html

AMD FirePro™ W2100 2GB Graphics Form Factor Low Profile, half length (full-height bracket included)

Graphics Controller AMD FirePro™ W2100 professional graphics based on Oland GPU.

GPU: 320 Stream Processors organized into 5 Compute Units

GPU Frequency: 630Mhz

Power: 26W



Technical Specifications - Graphics

Cooling: Active

Bus Type PCI Express® x8, Generation 3.0

Memory 2GB DDR3 memory

Memory Bandwidth: up to 28.8 GB/s

Memory Width: 128 bit

Connectors 2x Display Port[™] 1.2 connectors

Factory Configured: No video cable adapter included After market option kit: No video cable adapter included

Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are

available as Factory Configuration or Option Kit accessories.

Maximum Resolution DisplayPort[™] 1.2:

- up to 4096x2160 x 24 bpp @ 60Hz

Dual Link DVI(I) (requires adapter cable): - up to 2560 x 1600 x 32 bpp @ 60Hz

Single Link-DVI(I)(requires adapter cable): - up to 1920 x 1200 x 32 bpp @ 60Hz

VGA (requires adapter cable): - up to 1920 x 1200 x 32 bpp @ 60Hz

Image Quality Features Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component.

High bandwidth scaler for high quality up and downscaling.

Display Output 2 x DisplayPort[™] 1.2a

Maximum number of displays: 2

Shading Architecture Shader Model 5.0

Supported Graphics APIs OpenCL™ 1.2, DirectX® 11.2/12, OpenGL® 4.4

OpenGL® 4.4 support with driver release 14.301.xxx

OpenCL™ 1.2 conformance expected with drive release 14.301.xxx

Available Graphics Drivers Windows10 (64-bit)

Windows 7 Professional 64-bit

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html



Technical Specifications - Graphics

Notes Depending on the card model, native DisplayPort™ connectors and/or

certified DisplayPort™ active or passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s)

may be required. See www.amd.com/FirePro™ for details.

NVIDIA® Quadro® P1000

4GB Graphics

Form Factor Dimensions:2.713" H x 5.7" L

Single Slot, Low Profile

Cooling: Active Weight: 129 grams

Graphics Controller NVIDIA® Quadro® P1000 Graphics Card

GPU: 640 NVIDIA® CUDA® cores

Max Power: 47 Watts

Bus Type PCI Express 3.0 x16

Memory Size: 4 GB GDDR5, 2500 MHz

Memory Interface: 128-bit memory interface Memory Bandwidth: 80 GB/s memory bandwidth

Connectors4mDP OutputsMaximum ResolutionDisplayPort™ 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz- supports Multi-Stream Transport (MST)

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output 4 mDP Connectors

Shading Architecture Full Microsoft DirectX® 12 Shader Model 5.1

Supported Graphics APIs OpenGL® 4.5

DirectX® 12 Vulkan™ 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute , OpenCL™

Available Graphics Drivers Microsoft Windows 10

Microsoft Windows 7 Professional 64-bit

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

NVIDIA® Quadro® P2000

5GB Graphics

Form Factor Dimensions: 4.4"Hx7.9"L

Single Slot Cooling: Active Weight: 260 grams

Graphics Controller NVIDIA® Quadro® P2000 Graphics Card

Power: 75 Watts

Bus Type PCI Express 3.0 x16
Memory Size: 5GB GDDR5

Memory Bandwidth: 140 GB/s



Technical Specifications - Graphics

Memory Width: 160-bit

Connectors 4x DisplayPort™ 1.4

Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included

Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and

DisplayPort™ to Dual-Link DVI adapters available as accessories.

Maximum Resolution DisplayPort™:

- up to 5120 x 2880 x 24 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3

& 1.4 ready.

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60 Hz

Single Link-DVI(I) output:

- up to 1920 x 1200 x 32 bpp @ 60Hz

HDMI 2.0 (requires DP to HDMI adapter):

5120 x 2880 x 24 bpp @ 60Hz

Image Quality Features 12-bit internal display pipeline (hardware support for 12-bit scanout on

supported panels, applications and connection)

Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology,

NVIDIA® Mosaic and nView.

Display Output Maximum number of displays

- 4 direct attached monitors

Maximum number of monitors across all available Quadro P2000 outputs is

4.

Shading Architecture

Shader Model 5.1

Supported Graphics APIs

OpenGL[®] 4.5 DirectX[®] 12

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and

Fortran software

Available Graphics Drivers Microsoft Windows 10

Microsoft Windows 7 Professional 64bit

Linux® - Full OpenGL® implementation, complete with NVIDIA® and ARB

extensions

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

Form Factor Dimensions: 4.4"H x 7.9"L



Technical Specifications - Graphics

NVIDIA® Quadro® P2200 5GB Graphics

Single Slot, Full Height Weight: 260 grams

Graphics Controller NVIDIA® Quadro® P2200 Graphics Card

GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active

Bus TypePCI Express 3.0 x16MemorySize: 5GB GDDR5X

Memory Bandwidth: 200 GB/s Memory Width: 160-bit

Connectors 4x DisplayPort[™] 1.4

Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included

Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.

Maximum Resolution DisplayPort™:

- up to 5120 x 2880 x 24 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3

& 1.4 ready.

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60 Hz

Single Link-DVI(I) output:

- up to 1920 x 1200 x 32 bpp @ 60Hz

HDMI 2.0 (requires DP to HDMI adapter):

5120 x 2880 x 24 bpp @ 60Hz

Image Quality Features 12-bit internal display pipeline (hardware support for 12-bit scanout on

supported panels, applications and connection)

Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology,

NVIDIA® Mosaic and nView.

Display Output Maximum number of displays

- 4 direct attached monitors

Maximum number of monitors across all available NVIDIA® Quadro® P2200

outputs is 4.

Shading Architecture Shader Model 5.1

Supported Graphics APIs OpenGL® 4.5

DirectX® 12

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and

Fortran software



Technical Specifications - Graphics

Available Graphics Drivers Microsoft Windows 10

Microsoft Windows 7 Professional 64bit

Linux® - Full OpenGL® implementation, complete with NVIDIA® Quadro®

and ARB extensions

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

 Quadro P2200 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be

ordered separately.

2. Quadro P2200 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

AMD Radeon™ Pro WX 3100 4GB Graphics **Form Factor**

Low-Profile Single Slot (6.6" Length)

Graphics Controller

Polaris12 GL

GPU: 512 Stream Processors organized into 8 Compute Units

Power: 50 Watts Cooling: Active

Memory 4GB GDDR5 memory

Memory Bandwidth: 6 Gbps / 96 GB/s

Memory Width: 128 bit

Connectors

2x Mini DisplayPort™ 1.4 plus 1x DisplayPort™ 1.4 – HDR ready connectors

with HBR3 and MST support.

Factory Configured: No adapters included

After market option kit: One mDP-to-DP cable adapters included

Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or

Option Kit accessories.

Maximum Resolution

5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

3x 4K support @ 60Hz

Image Quality Features

Advanced support for 8-bit and 10-bit per RGB color component. High

bandwidth scaler for high quality up and downscaling

Display Output 3 full physical DP1.3 HBR3 / DP1.4 HDR outputs

FreeSync support

GPU Architecture

Polaris

Supported Graphics APIs DirectX°12

OpenGL[®] 4.5 OpenCL[™] 2.0 Vulkan[™] 1.0

Available Graphics Drivers Windows 10

(Windows® 7 64-bit available from AMD)
Linux® 64-bit (selected Enterprise distributions)



HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

- HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
- AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 3. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

AMD Radeon™ Pro WX 3200 4GB Graphics

Form Factor

Low-Profile Single Slot (2.75 "H x 6.6" L)

Graphics Controller

Radeon™ Pro WX 3200 Graphics Card

GPU: 640 Stream Processors organized into 8 Compute Units

Power: 56 Watts Cooling: Active

Memory 4GB GDDR5 memory

Memory Bandwidth: 96 GB/s Memory Width: 128 bit

Connectors

4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST

support.

Factory Configured: No adapters included

After market option kit: One mDP-to-DP cable adapters included

Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or

Option Kit accessories.

Maximum Resolution 5K support @ 60Hz

• 1x single-cable 5K monitor, or 2x dual-cable 5K monitors

4x 4K support @ 60Hz

Image Quality Features Advanced support for 8-bit and 10-bit per RGB color component. High

bandwidth scaler for high quality up and downscaling

Display Output 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs

FreeSync support



GPU Architecture Polaris

Supported Graphics APIs DirectX°12

OpenGL[®] 4.6 OpenCL[™] 2.0 Vulkan[™] 1.0

Available Graphics Drivers Windows 10

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

- 4. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
- 5. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 6. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Radeon™ Pro WX 4100 4GB Graphics

Form Factor Low-Profile Single Slot (6.6" Length)

Graphics Controller Polaris 11 Baffin GL XT

GPU: 1024 Stream Processors organized into 16 Compute Units

Power: 50 Watts Cooling: Active

Memory 4GB GDDR5 memory

Memory Bandwidth: 6 Gbps / 96 GB/s

Memory Width: 128 bit

Connectors 4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST

support.

Factory Configured: Four mDP-to-DP cable adapters included After market option kit: Four mDP-to-DP cable adapters included

Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are

available as Factory Configuration or Option Kit accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

4x 4K support @ 60Hz

Image Quality Features Advanced support for 8-bit and 10-bit per RGB color component. High

bandwidth scaler for high quality up and downscaling

Display Output 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs

FreeSync support

GPU Architecture GCN 4th Generation

Supported Graphics APIs DirectX°12

OpenGL[®] 4.5 OpenCL[™] 2.0 Vulkan[™] 1.0

Available Graphics Drivers Windows 10

Windows® 7 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

- 7. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
- 8. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 9. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windows mode content requires operating system support.

NVIDIA® T1000 4GB

Graphics

Form Factor Dimensions: 2.713" H x 6.137" L

Single Slot Weight: xx

Graphics Controller NVIDIA® T1000 Graphics Card

Power: 50W Cooling: Active

Bus TypePCI Express 3.0 x16MemorySize: 4GB GDDR6

Memory Bandwidth: Up to 160 GB/s

Memory Width: 128-bit

Connectors4x mini DisplayPort™ 1.4aMaximum Resolution7680 x 4320 @ 120Hz



Technical Specifications - Graphics

Display Output Maximum number of displays: 4 displays

Architecture NVIDIA® Turing™

Supported Graphics APIs xx

Available Graphics Drivers Microsoft Windows 10

Windows 8.1

Microsoft Windows 7 Professional 64bit

Linux® - Full OpenGL® implementation, complete with NVIDIA® Quadro®

and ARB extensions

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® Quadro® P4000

8GB Graphics

Form Factor Dimensions: 4.4"H x 9.5"L

Single-slot, full-height

Weight: 475 grams (without extender)

Graphics Controller NVIDIA® Quadro® P4000 Graphics Card

GPU: 1792 CUDA cores Power: 120 Watts

Bus Type PCI Express 3.0 x16

Memory Size: 8GB GDDR5

Memory Bandwidth: 243 GB/s Memory Width: 256-bit

Connectors 4 x DisplayPort 1.4

3-pin mini-DIN connector via optional bracket

1 x 6-pin auxiliary power connector 4-pin header for stereo signal SYNC connector for Quadro® Sync II

2 x SLI connectors

Factory Configured Option: No video cable adapter included After Market Option: No video cable adapter included

Additional DisplayPort-to-VGA, DisplayPort-to-HDMI, or DisplayPort-to-DVI

adapters are available as accessories

Maximum Resolution Dual-link internal TMDS (DVI 1.0):

- up to 2560 x 1600 x 32 bpp @ 60 Hz

Single-link internal TMDS (DVI 1.0): - up to 1920 x 1200 x 32 bpp @ 60 Hz

HDMI[™] 2.0b (requires DP to HDMI adapter): - up to 5120 x 2880 x 24 bpp @ 60Hz

DisplayPort:

up to 4096 x 2160 x 30 bpp @ 60Hz
 up to 2560 x 1600 x 30 bpp @ 120 Hz



- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

Using two DP outputs, the P4000 can drive one dual DP input display with

5120 x 2880 x 30 bpp @ 60Hz resolution.

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB color

component.

HDCP 2.2 support over DisplayPort, DVI, and HDMI connectors

NVIDIA 3D Vision™ and other 3D stereo technologies

NVIDIA Mosaic and nView

Display Output Maximum number of displays

- 4 direct attached monitors

Maximum number of monitors across all available Quadro P4000 outputs is

4.

Shading Architecture Shader Model 5.1

Supported Graphics APIs OpenGL 4.5

DirectX 12 Vulcan 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers Microsoft Windows 10

Microsoft Windows 7

Linux - Full OpenGL implementation, complete with NVIDIA and ARB

extensions

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

1. Quadro P4000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be

ordered separately.

2. Quadro P4000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

NVIDIA® Quadro® GP100 16GB Graphics

Form Factor Dual Slot (4.4" Height x 10.5" Length)

Weight: 989 grams +72 grams extender

Graphics Controller NVIDIA® QUADRO® GP100

GPU: 3584 NVIDIA CUDA® Parallel Processing Cores

Power: 235 Watts Cooling: Active

Memory 16GB HBM2

Memory Bandwidth: Up to 717 GB/s

Memory Width: 4096-bit

ECC Memory (disabled by default)

Technical Specifications - Graphics

Connectors DP (x4) with HDR support

DL-DVI(D)

3-pin mini-DIN connector via optional bracket

4-pin header for stereo signal

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

(2x) NVLink connectors

Factory configured option: 8-pin power adapter included with card. After market option Kit: 8-pin power adapter included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort[™] to Dual-Link DVI adapters available as accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features HDR support over DisplayPort™ 1.4 (SMPTE 2084/2086,

BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz

10b HEVC Encode)

HDCP 2.2 support over DisplayPort™, DVI, and HDMI

connectors

NVIDIA 3D Vision™ technology

NVIDIA Mosaic and nView Desktop Management

Display Outputs 4x DP1.4 MST & HDR2 outputs (up to 5120 x 2880 @ 60Hz)

> 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz) 1x Single-link DVI-D output (up to 1920 x 1200 @ 60 Hz)

HDMI™ 2.0b (up to 5120 x 2880 @ 60Hz)*

*requires DP to HDMI adapter

GPU Architecture NVIDIA Pascal™

Supported Graphics

DirectX®12, OpenGL® 4.5, Vulkan™ 1.0

APIs

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL, Java, Python, and Fortran

Available Graphics

Windows® 10

Drivers

Windows® 7 Professional 64-bit

Linux®



HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters

included

After market option kit: No adapters included

NVIDIA® Quadro® P5000 16GB Graphics **Form Factor** Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 815 grams / 1.80 lbs

Graphics Controller Quadro™ P5000 graphics

GPU: 2560 NVIDIA® CUDA® Parallel Processing Cores

Power: 180 Watts Cooling: Active

Memory 16GB GDDR5X memory

Memory Bandwidth: Up to 288 GB/s

Memory Width: 256 bit

ECC Memory (disabled by default)

Connectors DP (x4) with HDR support

DL-DVI(D)

3-pin mini-DIN connector

SLI connector

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort[™] to VGA, DisplayPort[™] to DVI, and DisplayPort[™] to Dual-Link DVI adapters available as accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality

Features

Advanced support for 8-bit, 10-bit, and 12-bit per RGB

color component.

HDCP 2.2 support over DisplayPort™, DVI, and HDMI

connectors

NVIDIA 3D Vision™ and other 3D stereo technologies



NVIDIA® Mosaic and nView Desktop Management

Display Outputs¹ 4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up

to 8K at 30Hz)

1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200

@ 120 Hz)

GPU Architecture NVIDIA® Pascal™

Supported Graphics DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

APIs Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers Windows® 7 64-bit

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

Windows® 10 64-bit

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 4 displays

NVIDIA® Quadro® P6000 24GB Graphics **Form Factor** Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 967 grams / 2.14 lbs

Graphics Controller NVIDIA® Quadro® P6000 graphics

GPU: 3840 NVIDIA® CUDA® Parallel Processing Cores

Power: 250 Watts Cooling: Active

Memory 24GB GDDR5X memory

Memory Bandwidth: Up to 432 GB/s

Memory Width: 384 bit

ECC Memory (disabled by default)

Connectors DP (x4) with HDR support

DL-DVI(D)

3-pin mini-DIN connector

SLI connector

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

Factory configured option: No video cable adapter included with

card.

After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB

color component.

HDCP 2.2 support over DisplayPort[™], DVI, and HDMI

connectors

NVIDIA® 3D Vision™ and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Outputs¹ 4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up

to 8K at 30Hz)

1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and

1920x1200 @ 120 Hz)

GPU Architecture NVIDIA® Pascal™

Supported Graphics

APIs

DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10 64-bit

Windows® 7 64-bit

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 4 displays

NVIDIA® Quadro® RTX Form Factor 4000 8GB Graphics

Full-Height Single Slot (4.4" Height x 9.5" Length)

Weight: 550 grams / 1.21 lbs

Graphics Controller NVIDIA® Quadro® RTX 4000 Graphics

GPU: 2304 NVIDIA® CUDA® Parallel Processing Cores

Power: 160 Watts Cooling: Active



Technical Specifications - Graphics

8GB GDDR6 memory Memory

Memory Bandwidth: Up to 416 GB/s

Memory Width: 384 bit

Connectors 3x DP 1.4a and VirtualLink

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

Factory configured option: No video cable adapter included with

card.

After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort[™] to Dual-Link DVI adapters available as accessories.

Maximum Resolution 7680x4320 @ 60Hz

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB

color component.

HDCP 2.2 support over DisplayPort™, DVI, and HDMI

connectors

NVIDIA® 3D Vision™ and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Outputs¹ 3x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)

Supported Graphics

APIs

DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10 64-bit Windows® 7 64-bit

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

1- Supports up to a total of 4 displays **Notes**

NVIDIA® Quadro® RTX Form Factor

5000 16GB Graphics

Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 1050 grams / 2.31 lbs



Technical Specifications - Graphics

Graphics Controller NVIDIA® Quadro® RTX 5000 Graphics

GPU: 3072 NVIDIA® CUDA® Parallel Processing Cores

Power: 265 Watts Cooling: Active

Memory 16GB GDDR6 memory

Memory Bandwidth: Up to 448 GB/s

Memory Width: 384 bit

Connectors 4x DP 1.4a and VirtualLink

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin + 6-pin auxiliary power connector

Factory configured option: No video cable adapter included with

card.

After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort[™] to VGA, DisplayPort[™] to DVI, and DisplayPort[™] to Dual-Link DVI adapters available as accessories.

Maximum Resolution 7680x4320 @ 60Hz

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB

color component.

HDCP 2.2 support over DisplayPort™, DVI, and HDMI

connectors

NVIDIA® 3D Vision™ and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Outputs¹ 4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)

Supported Graphics

DirectX[®]12, OpenGL[®] 4.5, OpenCL[™] 1.0, Vulkan[™] 1.0

APIs

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10 64-bit Windows® 7 64-bit

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 4 displays

Technical Specifications - Graphics

NVIDIA® Quadro® RTX Form Factor Full-Height Dual Slot (4.4" Height x 10.5" Length)

6000 24GB Graphics

Weight: 1070 grams / 2.35 lbs

Graphics Controller NVIDIA® Quadro® RTX 6000 Graphics

GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores

Power: 295 Watts Cooling: Active

Memory 24GB GDDR6 memory

Memory Bandwidth: Up to 672 GB/s

Memory Width: 384 bit

Connectors 4x DP 1.4a and VirtualLink

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin + 6-pin auxiliary power connector

Factory configured option: No video cable adapter included with

card.

After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.

Maximum Resolution 7680x4320 @ 60Hz

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB

color component.

HDCP 2.2 support over DisplayPort[™], DVI, and HDMI

connectors

NVIDIA® 3D Vision™ and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Outputs¹ 4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)

Supported Graphics DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

APIs Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL™, Java, Python, and Fortran

Available Graphics Windows® 10 64-bit

Drivers Windows® 7 64-bit

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:



Technical Specifications - Graphics

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 4 displays

NVIDIA® RTX A4000 16GB Form Factor

Graphics

Full-Height Single Slot (4.4" Height x 9.5" Length)

Graphics Controller NVIDIA® RTX A4000 Graphics

GPU: 6144 NVIDIA® CUDA® Parallel Processing Cores

Power: 140 Watts Cooling: Active

Memory 16GB GDDR6 memory

Memory Bandwidth: Up to 448 GB/s

Memory Width: 256 bit

Connectors 4x DP

One 6-pin auxiliary power connector

Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to

Dual-Link DVI adapters available as accessories.

Maximum Resolution 7680x4320 @ 60Hz

Display Outputs¹ 4x DP

Supported Graphics APIs DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0,

OpenCL™, Java, Python, and Fortran

Available Graphics Drivers Windows® 10 64-bit

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® RTX A5000 24GB Form Factor

Graphics

Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 1049 grams + 80 grams extender

Graphics Controller NVIDIA® RTX A5000

GPU: 8192 CUDA Cores

Power: 230W Cooling: Active



Technical Specifications - Graphics

Memory 24GB GDDR6

Memory Bandwidth: Up to 768GB/s ECC Memory (disabled by default)

Connectors DP (x4) with HDR support

One 8-pin auxiliary power connector

After market option Kit: no power adapter included with card.

DisplayPort™ to VGA, DisplayPort™ to DVI (single-link and dual-link), and

DisplayPort™ to HDMI adapters available as accessories.

Maximum Resolution DisplayPort™ 1.4a:

7680x4320 @ 120Hz

Display Outputs 4x DP1.4a HDR2 outputs (up to 7680x4320 @ 120Hz)

GPU Architecture NVIDIA® Ampere™

Supported Graphics APIs DirectX®12, OpenGL® 4.5

Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0,

OpenCL™, Java, Python, and Fortran

Available Graphics Drivers Windows® 10 64-bit

Windows® 7 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Factory Configured (Z4/Z6/Z8 G4 Workstation): No adapters included

After market option kit: No adapters included

NVIDIA® RTX™ A6000

48GB Graphics

Form Factor Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 1230 grams / 2.71 lbs (with extender)

Graphics Controller NVIDIA® RTX™ A6000 Graphics

GPU: 10752 NVIDIA® CUDA® Parallel Processing Cores

Power: 300 Watts Cooling: Active

Memory 48GB GDDR6 memory

ECC optional

Memory Bandwidth: Up to 768 GB/s

Memory Width: 384 bit

Connectors 4x DP 1.4a

Quadro Sync II connector

Ampere NVLink®



Technical Specifications - Graphics

Stereo Sync

Requires 8-pin CPU auxiliary power

Maximum Resolution 5120x2880 @ 60Hz (up to 4 displays)

Display Outputs 4x DP 1.4 (7680x4320 @ 60Hz)

Supported Graphics APIs DirectX°12, OpenGL° 4.6, OpenCL™ 1.0, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0,

OpenCL™, Java, Python, and Fortran™

Available Graphics Drivers Windows® 10 64-bit

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® Quadro® RTX 8000 48GB Graphics Form Factor Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 1070 grams / 2.35 lbs

Graphics Controller NVIDIA® Quadro® RTX 8000 Graphics

GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores

Power: 295 Watts Cooling: Active

Memory 48GB GDDR6 memory

Memory Bandwidth: Up to 672 GB/s

Memory Width: 384 bit

Connectors 4x DP 1.4a and VirtualLink

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin + 6-pin auxiliary power connector

Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to

Dual-Link DVI adapters available as accessories.

Maximum Resolution 7680x4320 @ 60Hz

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB color

component.

HDCP 2.2 support over DisplayPort™, DVI, and HDMI

connectors

NVIDIA® 3D Vision™ and other 3D stereo technologies



Technical Specifications - Graphics

NVIDIA® Mosaic and nView

Display Outputs¹ 4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)

Supported Graphics APIs DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0,

OpenCL™, Java, Python, and Fortran

Available Graphics Drivers Windows® 10 64-bit

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 4 displays

2- VirtualLink's USB-C™ (data) cannot be disabled at a hardware

level

Radeon™ Pro WX 7100 8GB Graphics

Form Factor

Full-Height Single Slot (9.5" Length)

Graphics Controller Radeon™ Pro WX 7100 graphics

GPU: 2304 Stream Processors organized into 36 Compute Units

Power: 130 Watts Cooling: Active

Memory 8GB GDDR5 memory

Memory Bandwidth: 7 Gbps / 224 GB/s

Memory Width: 256 bit

Connectors 4x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.

Factory Configured: No video cable adapter included After market option kit: No video cable adapter included

Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are

available as Factory Configuration or Option Kit accessories.

Maximum Resolution 5K support @ 60Hz

• 1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features Advanced support for 8-bit, 10-bit, and 16-bit per RGB color

component. High bandwidth scaler for high quality up and

downscaling

Display Output 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs

FreeSync support

GPU Architecture GCN 4th Generation



Supported Graphics APIs DirectX[®]12

OpenGL[®] 4.5 OpenCL[™] 2.0 Vulkan[™] 1.0

Available Graphics Drivers Windows 10

Windows® 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

- 10. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
- 11. Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro™ GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice.
- 12. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 13. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

AMD Radeon™ Pro WX Form Factor 9100 16GB Graphics

Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 1100 grams / 2.42 lbs

Graphics Controller AMD Radeon™ Pro WX 9100

Vega architecture GPU

GPU: 4096 NVIDIA® CUDA® Parallel Processing Cores

Power: 250 Watts Cooling: Active



Technical Specifications - Graphics

Memory 16GB HBM2 memory

Memory Bandwidth: Up to 483 GB/s

Memory Width: 384 bit

Connectors 6x mDP 1.4

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin + 6-pin auxiliary power connector

Factory configured option: No video cable adapter included with

card.

After market option Kit: 2x mini-DP to DP.

DVI to VGA, DisplayPort[™] to VGA, DisplayPort[™] to DVI, and DisplayPort[™] to Dual-Link DVI adapters available as accessories.

Maximum Resolution 7680 × 4320 resolution @ 60Hz

6x DP 1.3 4K @60Hz or 3x 5K @60Hz or 1x 8K @60Hz

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB

color component.

HDCP 2.2 support over DisplayPort™, DVI, and HDMI

connectors

NVIDIA® 3D Vision™ and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Outputs¹ 6x mDP 1.4 (7680x4320 @ 60Hz)

Supported Graphics

APIs

DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10 64-bit Windows® 7 64-bit

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 6 displays

NVIDIA® Quadro® Sync II Part number 1WT20AA

Dimensions (HxD) 6.0 inches × 4.2 inches

Devices Supported NVIDIA® Quadro® P4000



Technical Specifications - Graphics

NVIDIA® Quadro® P5000 NVIDIA® Quadro® P6000

Bus Type Requires one free mechanical PCle bus slot. 6-pin PCl or SATA power

connector

PCI Form Factor Full Height, half length, single slot

Ports 2 RJ45 connectors for carrying frame lock signals over CAT5 cables.

BNC Connector for external house synchronization.

Internal Connectors 6 NVIDIA SLI® style edge fingers for connection to compatible GPUs

Included with the board are 4 12-Inch Short Sync Cables to connect

to GPU's

Included with the board are 2 24-Inch Long Sync Cables to connect

to GPU's

System Requirements Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power

connector

Must be used with NVIDIA Quadro P4000, P5000 or P6000 graphics cards.

Requires Quadro driver version R375 or later.

Temperature -

 0° to 55° C

Operating

Temperature - Storage -40° to 60° C Relative Humidity - 10% to 80%

Operating

Power Requirements Board power dissipation: <15W

Operating Systems

Supported Windows 7 64-bit

Linux® 64-bit

Windows 10

Kit Contents Contains:

Quadro Sync II Card

4 x 12-Inch Short Sync Cables

2 x 24-Inch Long Sync Cables (Two)

Quick Start Guide



OPTICAL AND REMOVABLE STORAGE

HP 9.5mm Slim DVD

Writer

Description 9.5mm height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 128 x 9.5 x 127mm

Supported Media Types DVD+R

> DVD+RW DVD+R DL DVD-R DL DVD-R **DVD-RW** CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

> Full Stroke DVD < 200 ms (seek) Full Stroke CD < 200 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 8X

> DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

Power Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC -< 800 mA typical, <1600 mA

maximum

Operating Environmental

(all conditions non-

condensing)

Temperature

41° to 122° F (5° to 50° C)

10% to 80% **Relative Humidity**

Maximum Wet Bulb Temperature 84° F (29° C)

Operating Systems Windows 10, Windows 7 Professional 64-bit, Supported

Red Hat® Enterprise Linux®(RHEL) WS4**, 5, 6 Desktop/Workstation

SUSE Linux® Enterprise Desktop 10 & 11

* No driver is required for this device. Native support is provided by the

operating system.

Kit Contents HP SATA DVD Writer drive, installation guide.

Description 9.5mm height, tray-load



HP 9.5mm Slim DVD-ROM Mounting Orientation

Drive

Either horizontal or vertical

Interface Type

SATA / ATAPI

Dimensions (WxHxD)

128 x 9.5 x 127mm

Disc Capacity

DVD-ROM

Single layer: Up to 4.7 GB

Double layer: Up to 8.5 GB

Access Times

Power

DVD-ROM Single Layer CD-ROM Mode 1

< 110 ms (typical) < 230 ms (typical) < 220 ms (typical)

< 110 ms (typical)

Full Stroke DVD Full Stroke CD

Source

SATA DC power receptacle

DC Power Requirements

5 VDC ± 5%-100 mV ripple p-p

DC Current

5 VDC - <800mA typical, < 1600 mA

maximum

Operating Environmental Temperature (all conditions non-

condensing)

41° to 122° F (5° to 50° C) 10% to 80%

Relative Humidity Maximum Wet Bulb Temperature

84° F (29° C)

Operating Systems

Supported

Windows 10, Windows 7 Professional 64-bit

Red Hat® Enterprise Linux®(RHEL) WS4**, 5, 6 Desktop/Workstation

SUSE Linux® Enterprise Desktop 10 & 11

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents

9.5mm Slim DVD-ROM Drive, 5.25" ODD Bay adapter/carrier, slim SATA

data/power cable, installation guide

HP HH DVD Writer (16X

RW DVD-R)

Description

HP Half Height DVD Writer

Mounting Orientation

Either Horizontal or vertical

Interface Type

SATA

DVD+R

Dimensions (WxHxD)

146x42x165mm

Supported Media Types

DVD+RW DVD+R DL DVD-R DL DVD-R **DVD-RW** CD-R CD-RW

Disc Capacity

DVD-ROM

8.5 GB DL or 4.7 GB standard

Full Stroke DVD Full Stroke CD

145ms (seek) 120ms (seek)

Maximum Data Transfer

Rates

CD ROM Read

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read

DVD+RW Up to 13X



DVD-RW Up to 13X DVD+R DL Up to 12X DVD-R DL Up to 12X DVD-ROM Up to 12X DVD-ROM DL Up to 12X DVD+R Up to 16X DVD-R Up to 16X

Power Source SATA DC power receptacle

> 5 VDC ± 5% -100 mV ripple p-p **DC Power Requirements**

> > 12 VDC ± 10% -200 mV ripple p-p

DC Current 5 VDC -<1500mA typical, <2000 mA

maximum.

Operating Environmental

(all conditions non-

condensing)

Temperature Relative Humidity 41° to 122° F (5° to 50° C)

10% to 90% (Non-Condensing)

Operating Systems

Supported

Windows 10, Windows 7 Professional 64-bit. Red Hat Enterprise Linux

WS4**,5,6 Desktop/Workstation.

No driver is required for this device, Native support is provided by

operating system.

Kit Contents HP SATA DVD Writer drive, Installation guide.

HP 9.5mm Slim BDXL Blu- Description **Ray Writer**

9.5mm height, tray-load

Mounting Orientation

Either horizontal or vertical

Interface Type

SATA/ATAPI

Dimensions (WxHxD)

128 x 9.5 x 127mm

Supported Media Types

BD-ROM BD-R

BD-RE DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R **DVD-RW**

CD-R CD-RW

Blu-ray

Disc Capacity

DVD-ROM

8.5 GB DL or 4.7 GB standard

25 GB (single-layer)

50 GB (dual-layer) 100/128 GB (BDXL)

Full Stroke DVD < 230 ms (seek) Full Stroke CD < 220 ms (seek)

< 230 ms (seek) (Full Stroke Blu-ray) Blu-ray (Time to drive ready from tray loading) Startup Time

> BD-ROM (SL/DL) 255 / 285



BD-R (SL/DL) 25S / 28S BD-RE (SL/DL) 255 / 285 DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 25S / 25S

DVD-RW **25S**

DVD+R (SL/DL) 25S / 25S

DVD+RW **25S** CD-ROM **15S**

Maximum Data Transfer

Rates

CD ROM Read

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 8X

> DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

Blu-ray BD-ROM Up to 6X

BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-RE SL/DL Up to 6X

Power Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p DC Current 5 VDC -900 mA typical, 2000mA

> > maximum

Operating Environmental Temperature

(all conditions non-

condensing)

Supported

41° to 122° F (5° to 50° C)

Relative Humidity 10% to 80% Maximum Wet Bulb Temperature 84° F (29° C)

Windows 10, Windows 7 Professional 64-bit **Operating Systems**

Red Hat® Enterprise Linux® (RHEL) 6, 7 Desktop/Workstation

SUSE Linux® Enterprise Desktop 12

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents 9.5mm Slim BDXL Blu-Ray Writer, 5.25" ODD Bay adapter/carrier, slim SATA

data/power cable, installation guide

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support.

HD-DVD movies cannot be played on this workstation.

Technical Specifications – Optical and Removable Storage

HP SD Card Reader Description Supports hardware ECC (Error Correction Code) function

Supports hardware CRC (Cyclic Redundancy Check) function

Supports SD 4-bit parallel transfer mode

Interface Type USB 3.1 GEN 1 High-speed interface

Dimensions (WxHxD) 1.15 x .9 x .15 in (29.00 x 23.6 x 3.15 mm) Fits conveniently in the Front IO

Bay

Supported Media Types Secure Digital Card (SD)

Secure Digital High Capacity (SDHC)

SD Extended Capacity Memory Card (SDXC)

SD Ultra High Speed II(SD UHSII)

These additional media types are supported with a card adapter.

Memory Stick Micro (M2)

miniSD

miniSD High Capacity

Micro SD Memory Card (MicroSD)

Micro SD High Capacity Memory Card (MicroSDHC)

Test Parameters/Conditions - Power applied, unit operating on system ±5%

Operating Systems

Supported

Windows 10

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents Media card reader

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0,

Compliant Intel® Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE,

BSMI, C-Tick, VCCI, MIC, cUL, TUVT

Weight 0.35 lbs. (0.16 kg)



Technical Specifications - Controller Cards

CONTROLLER CARDS

HP Thunderbolt-3 Dual Data Transfer Rate Supports up to 40 Gb/s (40,000 Mb/s)

Port2 PCle 1-port I/O Card Devices Supported Thunderbolt™, Thunderbolt™ 2 and Thunderbolt™ 3 certified for Windows

devices

Bus Type PCIe card, full height PCIe slots

Ports Two Thunderbolt™ 3 external USB type-C output connectors (Rear)

Two full size DisplayPort input connectors (Rear)

Internal Connectors One 2x5-Pin header connector

System Requirements Windows 10 Professional, available dedicated PCH PCIe slot.

Temperature - Operating 50° to 131° F (10° to 55° C)

Temperature - Storage -22° to 140° F (-30° to 60° C)

Relative Humidity -

Operating

20% to 80%

Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD,

Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Windows 10 Professional.

Kit Contents HP Thunderbolt™ 3 Dual Port PCle I/O Card, 2- DisplayPort cables, GPIO

(General-Purpose Input/Output) cables, Installation documentation and

warranty card.



^{*}Maximum speed requires DisplayPort™ and PCIe aggregation.

Technical Specifications - Networking and Communications

NETWORKING AND COMMUNICATIONS

Integrated Intel® I219LM Connector RJ-45

Controller Intel® I219LM

Data Rates Supported 10/100/1000 Mbps

Boot ROM Support PXE, UEFI

Connect Speed LED Link/Activity LED

Indicators • Off = No link

Blinking = Activity

Speed LED

Off = 10Mbps

• Amber = 100Mbps

• Green = 1000Mbps

Management Capabilities Intel® Active Management Technology™ 11

Integrated Intel® X722 for Connector 1 RJ-45

1GbE

Controller Intel® X722 for 1GbE

Data Rates Supported1000 MbpsBoot ROM SupportPXE, UEFI

Connect Speed LED Link/Activity LED

Indicators • Off = No link

Blinking = Activity

Speed LED

Off = No Link

• Green = 1000Mbps

Management Capabilities Wake-On-LAN

HP Z Dual 10GbE Network Networking Interface 2 RJ-45

Module

System Interface Cabled from Dedicated Rear I/O Slot

Networking Speeds 1Gbps, 10Gbps

Supported

Cabling (up to 100m) Cat5e (or higher) for 1Gbps

Cat6a (or higher) for 10Gbps

Power Consumption 5.5W at 1Gbps

(active-typical) 11.2W at 10Gbps

Physical Dimensions 0.875 in x 3 in x 2.75 in

Connect Speed LED Link/Activity LED

Indicators • Off = No link

Blinking = Activity

Speed LED

• Amber = 1Gbps

Green = 10Gbps

Operating Temperature 0 °C to 55 °C (32 °F to 131 °F)

Technical Specifications - Networking and Communications

Intel® I210-T1 **Networking Interface** 1 RJ-45

> System Interface PCI Express 2.1 x1

Networking Speeds

Supported

10Mbps, 100Mbps, 1Gbps

Cabling (up to 100m) Cat3 (or higher) for 10Mbps

> Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps

Power Consumption

(active-typical)

0.81W

Physical Dimensions Length: 6.7cm (2.64 inches)

(Bracket) Width: 1.8cm (0.709 inches)

Full-height end bracket: 12.07cm (4.755 inches) Low-profile end bracket: 8cm (3.15 inches)

Connect Speed LED

Indicators

Link/Activity LED

Off = No link

Blinking = Activity

Speed LED

Off = 10Mbps

Green = 100Mbps

Amber = 1Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications USA: FCC B,

> EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

Canada: ICES-003/NMB-003

Intel® 1350-T2 **Networking Interface** 2 RJ-45

> **System Interface** PCI Express 2.1 x4

Networking Speeds

Supported

10Mbps, 100Mbps, 1Gbps

Cabling (up to 100m) Cat3 (or higher) for 10Mbps

> Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps

Power Consumption

(active-typical)

4.4W

Physical Dimensions Length: 13.54cm (5.33 inches)

Width: 6.89 (2.71 inches)

Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches)



Technical Specifications - Networking and Communications

Connect Speed LED Indicators

Link/Activity LED

Off = No link

Blinking = Activity

Speed LED

Off = 10Mbps

Green = 100Mbps

Amber = 1Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications

USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

Canada: ICES-003/NMB-003

Intel® 1350-T4

Networking Interface

4 RJ-45

System Interface

PCI Express 2.1 x4

Networking Speeds

Supported

10Mbps, 100Mbps, 1Gbps

Cabling (up to 100m)

Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps

Power Consumption

(active-typical)

5W

Physical Dimensions

Length: 13.54cm (5.33 inches)

Width: 6.89 (2.71 inches)

Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches)

Connect Speed LED

Indicators

Link/Activity LED

• Off = No link

Blinking = Activity

Speed LED

Off = 10Mbps

Green = 100Mbps

Amber = 1Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications USA: FCC B,

EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

Canada: ICES-003/NMB-003

Aquantia® AQN-108

Networking Interface

RJ-45



Technical Specifications - Networking and Communications

System Interface PCI Express 3 x1

Networking Speeds

Supported

100Mbps, 1Gbps, 2.5Gbps, 5Gbps
Cat5e (or higher) for all speeds

Cabling (up to 100m)
Power Consumption
(active-typical)

3.5W at 5Gbps, 3.0W at 2.5Gbps

Physical Dimensions

Connect Speed LED

Indicators

3.72 in x 3.18 in (without bracket)

Link/Activity LED

Off = No link

Blinking = Activity

Speed LED

Off = No link

Amber = <5Gbps

Green = 5Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications USA: FCC B,

EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

Canada: ICES-003/NMB-003

Intel® X550-T2 Networking Interface 2 x RJ-45

System Interface PCI Express 3 x4

Networking Speeds

Supported

100Mbps, 1Gbps, 2.5Gbps, 5Gbps, 10Gbps

Cabling (up to 100m) Cat5 (or higher) for 100Mbps

Cat5e (or higher) for 1Gbps, 2.5Gbps, or 5Gbps

Cat6a (or higher) for 10Gbps

Power Consumption (active-typical)

3.9W at 100Mbps 5.5W at 1Gbps 11.2W at 10Gbps

Physical Dimensions

5.2 in x 2.7 in (without bracket)

Connect Speed LED Indicators

Link/Activity LED

Off = No link

Blinking = Activity

Speed LED

Off = No link

• Amber = <10Gbps

Green = 10Gbps

Operating Temperature 0 °C to 55 °C (32 °F to 131 °F)

Technical Specifications - Networking and Communications

Hardware Certifications USA: FCC B,

> EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

Canada: ICES-003/NMB-003

Allied Telesis AT-2914SX/LC-901 1GB LC System Interface Fiber NIC

Network Interface Networking Speeds Supported

1Gb LC Fiber 850 nm PCIeG2 x1, Half Height, Half Length

1000Base-X (1Gbps)

Cabling

50/125 µm (core/cladding) multimode fiber optic cable up to 500m $62.5/125 \, \mu m$ (core/cladding) multimode fiber optic cable up to 220m

Power Consumption

(active-typical) **Physical Dimensions Connect Speed LED**

Indicators

Operating Temperature

1.5 Watts

8.8 cm x 6.9 cm (3.5 in x 2.7 in) ON: 1Gbps Link OFF: Link down

-25°C to 70°C (-13°F to 158°F) **Hardware Certifications**

IEEE 802.1p (Quality of Service), IEEE 802.1Q (VLANs), IEEE 802.2 (LLC), IEEE 802.3ac (MAC), IEEE 802.3x (Flow control auto-negotiation), IEEE 802.3z

(1000 Base-X), IEEE 802.3ad (Link aggregation)

RoHS, UL, FCC/EN55022 Class A, TUV, EN55024, CE, C-TICK, VCCI

Intel® X710-DA2 10GBASE-SR Converged **Network Adapter**

Networking Interface System Interface

2 SFP+ Ports for LC SFP+ Transceivers

Networking Speeds

Supported

PCI Express 3.0 x8 1Gbps, 10Gbps

Cabling

LC fiber optic cabling with LC SFP+ Transceivers

Power Consumption

(active-typical)

4.3W

Physical Dimensions

Connect Speed LED Indicators

6.578 in x 2.703 in Link/Activity LED

Off = No link

Blinking = Activity

Speed LED

Off = 10Mbps

Green = 100Mbps

Amber = 1Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)



Technical Specifications - Networking and Communications

Hardware Certifications USA: FCC B,

EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

Canada: ICES-003/NMB-003

Note: Windows 7 is NOT supported

10GbE SFP+ SR Transceiver Connector Type LC

Cable Type 62.5/125um or 50/125um (core/cladding), graded-index, low metal

content, multimode fiber optic, complying with ITU-T G.651 and ISO/IEC

793-2 Type A1b or A1a, respectively.

Cable Length2-300mWavelength850nmForm FactorSFP+

Physical Dimensions 0.47(h) x 0.54(w) x 2.19(d) inches

(1.19 x 1.38 x 5.57 cm)

Operating Temperature 0C to 45C (32F to 113F)
Operating Humidity 0% to 85%, noncondensing

Intel® 8265 WLAN

Networking Speeds 802.11ac MU-MIMO (up to 867 Mbps)

Bluetooth 4.2

IEEE WLAN Standard IEEE 802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w;

802.11r, 802.11k, 802.11v pending

Bluetooth 4.2

System Interface PCI Express 2.1 x1

Antenna 2x2

Summary of Changes

SUMMARY OF CHANGES

Date of change:	Version History:		Description of change:
November 1, 2017	From v1 to v2	Added	HP DisplayPort to HDMI Adapter, HP DisplayPort to VGA Adapter, NVIDIA SLI
			3-slot Graphics Connector and NVIDIA Quadro Sync II to Graphics section
			and Microsemi 3152-8i SAS ROC RAID Controller
		Changed	Graphics, Storage / Hard Drives and Memory sections, changed Front and
			internal view info on the Overview section, changed Operating Systems
			section, changed System Board section, Physical Security and Serviceability
			sections
November 29, 2017	From v2 to v3	Added	Processors, hard drives and graphics to offerings, added Declared Noise
			Emissions information
January 30, 2018	From v3 to v4	Removed	NVIDIA SLI Graphics Connectors from Graphics Cable Adapters section
March 27, 2018	From v4 to v5	Added	Intel Xeon processors added
April 16, 2018	From v5 to v6	Removed	RAID 5
August 13, 2018	From v6 to v7	Added	Footnote to Networking and Communications section
		Changed	Processors section and Operating Systems section
September 4, 2018	From v7 to v8	Removed	HP IEEE 1394b FireWire PCIe Card
September 6, 2018	From v8 to v9	Removed	Microsemi 3152-8i SAS ROC RAID Controller
September 21, 2018	From v9 to v10	Added	Intel Optane SSD 905p AiC 280GB & 480GB
September 26, 2018	From v10 to v11	Changed	NVIDIA Quadro P6000 Graphics specs
April 8, 2019	From v11 to v12	Added	New Intel Xeon Processors and graphics, added HP DX175 Removable HDD
			Carrier into the HDD Frame/Carriers section
		Changed	Storage / Hard Drives, Memory sections and format changes
May 15, 2019	From v12 to v13	Added	NVIDIA Quadro RTX 8000 48GB Graphics
		Changed	External BIOS simulator link on Physical Security and Serviceability section
		Removed	Intel 9260 WLAN
June 12, 2019	From v13 to v14	Changed	Storage section
July 7, 2019	From v14 to v15	Added	Intel Xeon W Processors
July 15, 2019	From v15 to v16	Changed	Corrected Intel 905p Series AIC 480GB PCIe SSD
August 1, 2019	From v16 to v17	Changed	Processors Matrix
September 1, 2019	From v17 to v18	Added	Footnote to Memory section, Added Optane 905P 380GB M.2 SSD Module,
			HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Kit & module to Storage section,
			Added Intel® Wi-Fi 6 AX200 & BT PCIe to Networking section
October 26, 2019	From v18 to v19	Changed	Graphics section
November 1, 2019	From v19 to v20	Added	NVDIMM Memory sections, Added HP QX310 Removable NVMe
			Frame/Carrier w/PCle card to Optical and Removable Storage section
January 2, 2020	From v20 to v21	Changed	Storage section
February 26, 2020	From v21 to v22	Added	New Intel Xeon Processors
		Changed	Overview, PCIe Solid State Drives sections
April 2, 2020	From v22 to v23	Changed	Processors and NVDIMM Memory sections
July 18, 2020	From v23 to v24	Changed	Processors, Graphics section
January 5, 2021	From v24 to v25	Changed	Processors, Memory, Graphics, Racking and Physical Security, Operating
			Systems and Hard Drives sections
February 1, 2021	From v25 to v26	Changed	NETWORKING AND COMMUNICATIONS section
March 1, 2021	From v26 to v27	Changed	Overview section
April 13, 2021	From v27 to v28	Changed	Processors, Graphics and Social and Environmental Responsibility sections
May 1, 2021	From v28 to v29	Changed	Graphics section
June 1, 2021	From v29 to v30	Changed	Memory and Graphics sections
July 1, 2021	From v30 to v31	Changed	Graphics section
August 1, 2021	From v31 to v32	Changed	Graphics section



Summary of Changes

September 1, 2021 From v32 to v33 Changed Input Devices and Graphics sections



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